To all our customers

Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note : Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

M37733S4LHP

New product

16-BIT CMOS MICROCOMPUTER

DESCRIPTION

The M37733S4LHP is a microcomputer using the 7700 Family core. This microcomputer has a CPU and a bus interface unit. The CPU is a 16-bit parallel processor that can be an 8-bit parallel processor, and the bus interface unit enhances the memory access efficiency to execute instructions fast. This microcomputer also includes a 32 kHz oscillation circuit, in addition to the RAM, multiple-function timers, serial I/O, A-D converter, and so on.

Its strong points are the low power dissipation, the low supply voltage and the small package.

FEATURES

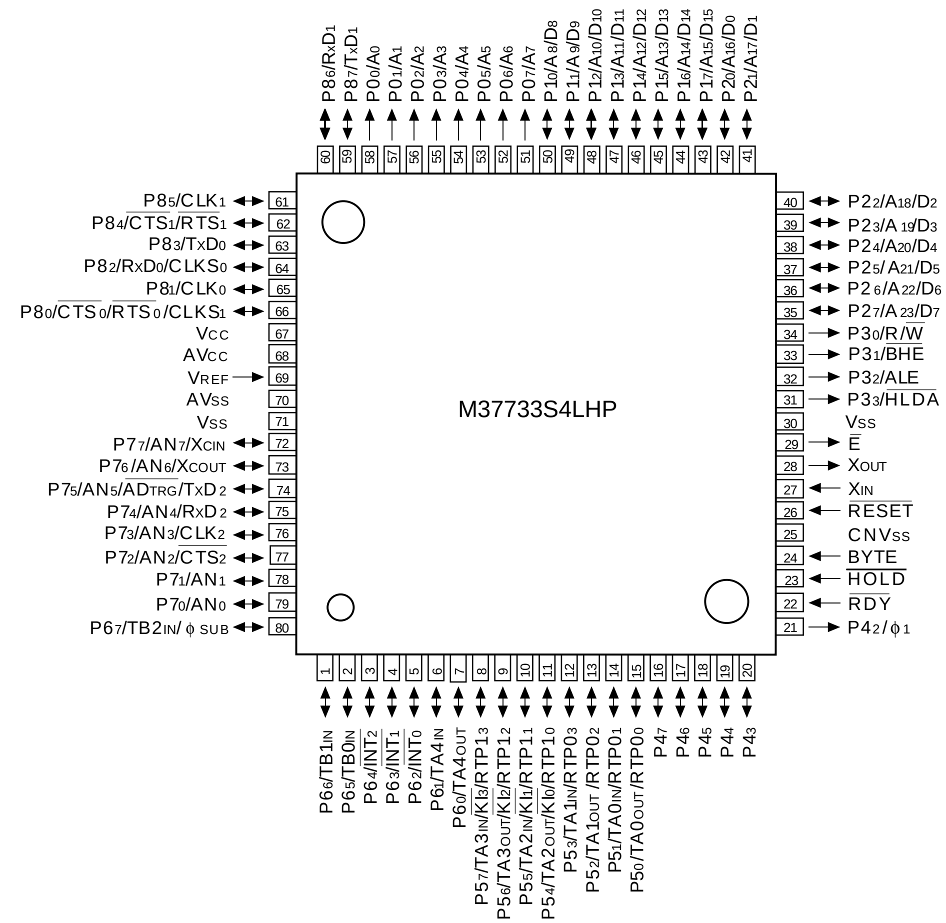
- ●Number of basic instructions 103
- ●Memory size RAM .... 2048 bytes
- ●Instruction execution time
  The fastest instruction at 12 MHz frequency .... 333 ns
- ●Single power supply .... 2.7–5.5 V
- ●Low power dissipation (At 3 V supply voltage, 12 MHz frequency) .... 10.8 mW (Typ.)
- ●Interrupts .... 19 types, 7 levels
- ●Multiple-function 16-bit timer .... 5 + 3
- ●Serial I/O (UART or clock synchronous).................................... 3
- ●10-bit A-D converter .... 8-channel inputs
- ●12-bit watchdog timer
- ●Programmable input/output
  (ports P4, P5, P6, P7, P8) 37
- ●Clock generating circuit .... 2 circuits built-in
- ●Small package .... 80-pin plastic molded fine-pitch QFP (80P6D-A;0.5 mm lead pitch)

APPLICATION

Control devices for general commercial equipment such as office automation, office equipment, personal information equipment, and so on.

Control devices for general industrial equipment such as communication equipment, and so on.

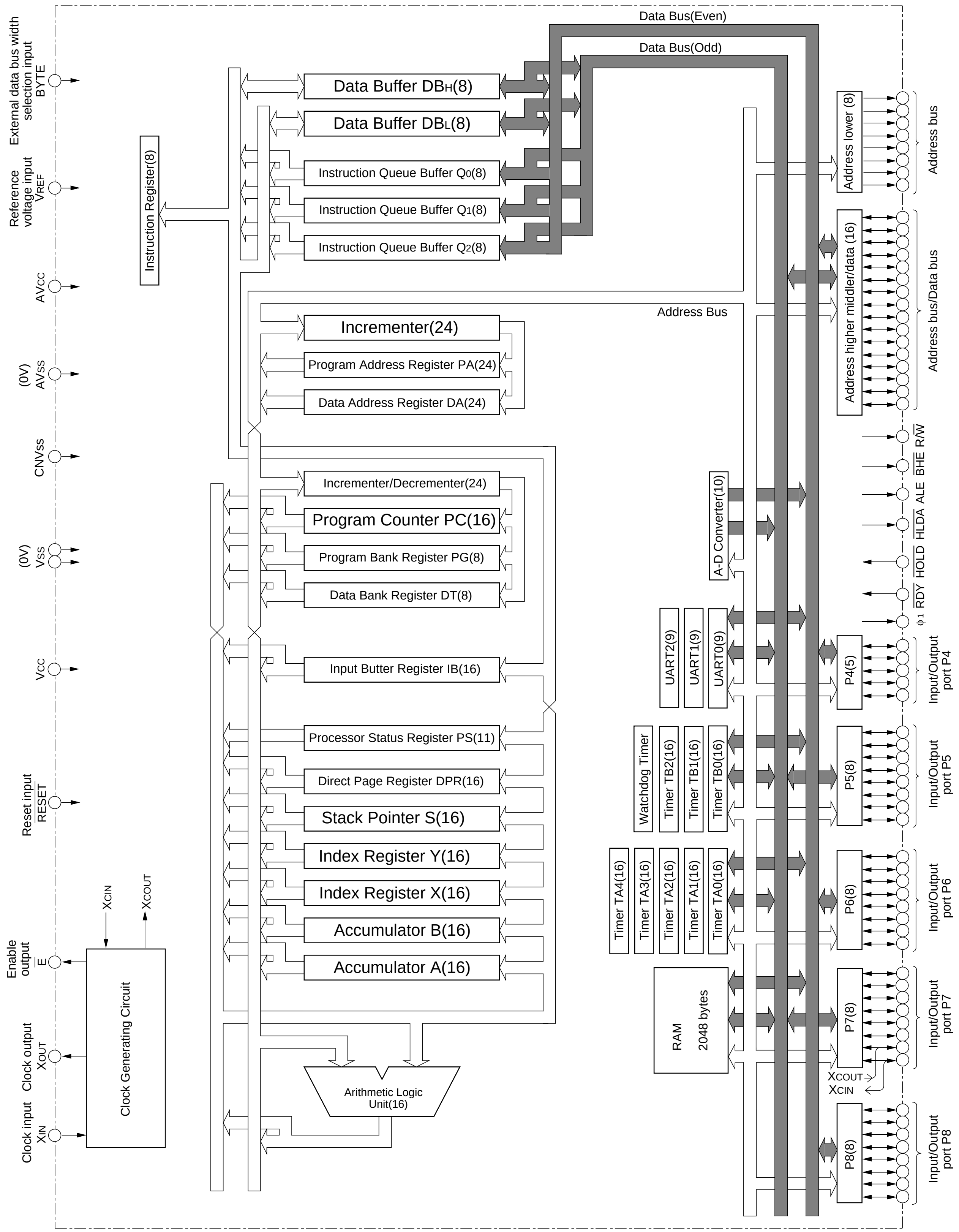
PIN CONFIGURATION (TOP VIEW)



Outline 80P6D-A

New product

M37733S4LHP BLOCK DIAGRAM



FUNCTIONS OF M37733S4LHP

Parameter		Functions
Number of basic instructions		103
Instruction execution time		333 ns (the fastest instruction at external clock 12 MHz frequency)
Memory size	RAM	2048 bytes
Input/Output ports	P5 – P8	8-bit ✕ 4
	P4	5-bit ✕ 1
Multi-function timers	TA0, TA1, TA2, TA3, TA4	16-bit ✕ 5
	TB0, TB1, TB2	16-bit ✕ 3
Serial I/O		(UART or clock synchronous serial I/O) ✕ 3
A-D converter		10-bit ✕ 1 (8 channels)
Watchdog timer		12-bit ✕ 1
Interrupts		3 external types, 16 internal types Each interrupt can be set to the priority level (0 – 7.)
Clock generating circuit		2 circuits built-in (externally connected to a ceramic resonator or a quartz-crystal oscillator)
Supply voltage		2.7 – 5.5 V
Power dissipation		10.8 mW (at 3 V supply voltage, external clock 12 MHz frequency)
		27 mW (at 5 V supply voltage, external clock 12 MHz frequency)
Input/Output characteristic	Input/Output voltage	5 V
	Output current	5 mA
Memory expansion		Maximum 16 Mbytes
Operating temperature range		–40 to 85 °C
Device structure		CMOS high-performance silicon gate process
Package		80-pin plastic molded fine-pitch QFP (80P6D-A;0.5 mm lead pitch)

PIN DESCRIPTION

Pin	Name	Input/Output	Functions
Vcc, Vss	Power source		Apply 2.7 – 5.5 V to Vcc and 0 V to Vss.
CNVss	CNVss input	Input	Connect to Vcc.
$\overline{RESET}$	Reset input	Input	When “L” level is applied to this pin, the microcomputer enters the reset state.
X_{IN}	Clock input	Input	These are pins of main-clock generating circuit. Connect a ceramic resonator or a quartz crystal oscillator between X_{IN} and X_{OUT}. When an external clock is used, the clock source should be connected to the X_{IN} pin, and the X_{OUT} pin should be left open.
X_{OUT}	Clock output	Output	
$\overline{E}$	Enable output	Output	When output level of $\overline{E}$ signal is “L”, data/instruction read or data write is performed.
BYTE	Bus width selection input	Input	This pin determines whether the external data bus has an 8-bit width or a 16-bit width. The data bus has a 16-bit width when “L” signal is input and an 8-bit width when “H” signal is input.
AVcc, AVss	Analog power source input		Power source input pin for the A-D converter. Externally connect AVcc to Vcc and AVss to Vss.
V_{REF}	Reference voltage input	Input	This is reference voltage input pin for the A-D converter.
$P0_0/A_0$ – $P0_7/A_7$	Address (low-order) output	Output	Address (A_0 – A_7) is output.
$P1_0/A_8/D_8$ – $P1_7/A_{15}/D_{15}$	Address (middle-order) output/data (high-order) I/O	I/O	When the BYTE pin is set to “L” and external data bus has a 16-bit width, high-order data (D_8 – D_{15}) is input/output or an address (A_8 – A_{15}) is output. When the BYTE pin is “H” and an external data bus has an 8-bit width, only address (A_8 – A_{15}) is output.
$P2_0/A_{16}/D_0$ – $P2_7/A_{23}/D_7$	Address (high-order) output/data (low-order) I/O	I/O	Low-order data (D_0 – D_7) is input/output or an address (A_{16} – A_{23}) is output.
$P3_0/R/\overline{W}$	Read/Write output	Output	“H” indicates the read status and “L” indicates the write status.
$P3_1/\overline{BHE}$	Byte high enable output	Output	“L” is output when an odd-numbered address is accessed.
$P3_2$/ALE	Address latch enable output	Output	This is used to retrieve only the address from address and data multiplex signal.
$P3_3/\overline{HLDA}$	Hold acknowledge output	Output	This outputs “L” level when the microcomputer enters hold state after a hold request is accepted.
$\overline{HOLD}$	Hold request input	Input	This is an input pin for $\overline{HOLD}$ request signal. The microcomputer enters into hold state while this signal is “L”.
$\overline{RDY}$	Ready input	Input	This is an input pin for $\overline{RDY}$ signal. The microcomputer enters into ready state while this signal is “L”.
$P4_2/\phi_1$	Clock output	Output	This pin outputs the clock ϕ_1.
$P4_3$ – $P4_7$	I/O port P4	I/O	These pins become a 5-bit I/O port. An I/O direction register is available so that each pin can be programmed for input or output. These ports are in the input mode when reset.
$P5_0$ – $P5_7$	I/O port P5	I/O	In addition to having the same functions as port P4, these pins also function as I/O pins for timers A0 to A3 and input pins for key input interrupt input ($\overline{KI_1}$ – $\overline{KI_3}$).
$P6_0$ – $P6_7$	I/O port P6	I/O	In addition to having the same functions as port P4, these pins also function as I/O pins for timer A4, input pins for external interrupt input ($\overline{INT_0}$ – $\overline{INT_2}$) and input pins for timers B0 to B2. $P6_7$ also functions as sub-clock ϕ_{SUB} output pin.
$P7_0$ – $P7_7$	I/O port P7	I/O	In addition to having the same functions as port P4, these pins function as input pins for A-D converter. $P7_2$ to $P7_5$ also function as I/O pins for UART2. Additionally, $P7_6$ and $P7_7$ have the function as the output pin (X_{COUT}) and the input pin (X_{CIN}) of the sub-clock (32 kHz) oscillation circuit, respectively. When $P7_6$ and $P7_7$ are used as the X_{COUT} and X_{CIN} pins, connect a resonator or an oscillator between the both.
$P8_0$ – $P8_7$	I/O port P8	I/O	In addition to having the same functions as port P4, these pins also function as I/O pins for UART 0 and UART 1.

BASIC FUNCTION BLOCKS

The M37733S4LHP has the same functions as the M37733MHBXXXFP except for the following :
(1) The memory map is different.
(2) The processor mode is different.
(3) The reset circuit is different.
(4) Pulse output port mode of timer A is available.
(5) The function of ROM area modification is not available.

MEMORY

The memory map is shown in Figure 1. The address space has a capacity of 16 Mbytes and is allocated to addresses from 0_{16} to $FFFFFF_{16}$. The address space is divided by 64-Kbyte unit called bank. The banks are numbered from 0_{16} to FF_{16}.
Built-in RAM and control registers for internal peripheral devices are assigned to bank 0_{16}.
Addresses $FFD6_{16}$ to $FFFF_{16}$ are the RESET and interrupt vector addresses and contain the interrupt vectors. Use ROM for memory of this address.
The 2048-byte area allocated to addresses from 80_{16} to $87F_{16}$ is the built-in RAM. In addition to storing data, the RAM is used as stack during a subroutine call or interrupts.
Peripheral devices such as I/O ports, A-D converter, serial I/O, timer, and interrupt control registers are allocated to addresses from 0_{16} to $7F_{16}$.
A 256-byte direct page area can be allocated anywhere in bank 0_{16} by using the direct page register (DPR). In the direct page addressing mode, the memory in the direct page area can be accessed with two words. Hence program steps can be reduced.

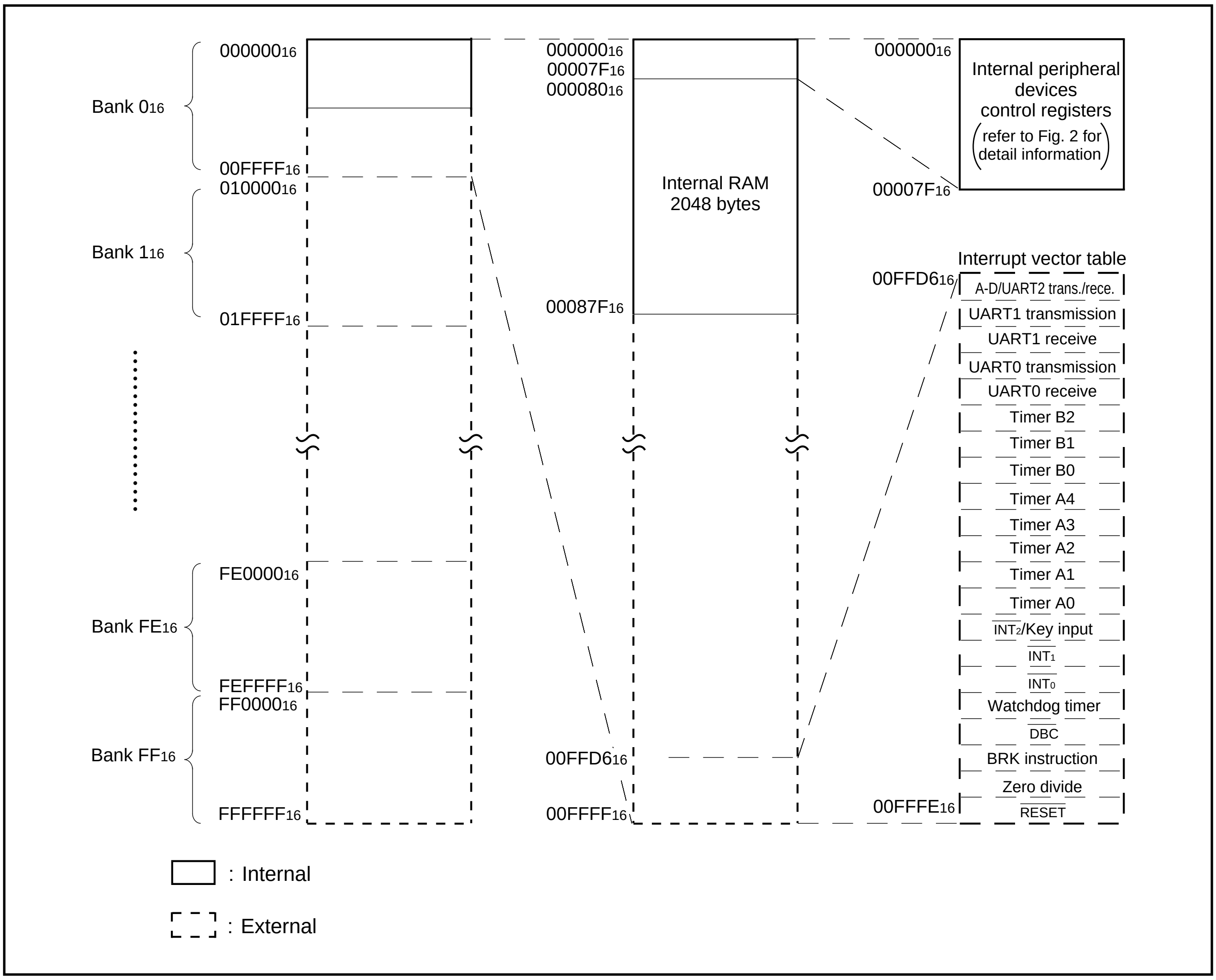


Fig. 1 Memory map

Address (Hexadecimal notation)	
000000	
000001	
000002	Port P0 register
000003	Port P1 register
000004	Port P0 direction register
000005	Port P1 direction register
000006	Port P2 register
000007	Port P3 register
000008	Port P2 direction register
000009	Port P3 direction register
00000A	Port P4 register
00000B	Port P5 register
00000C	Port P4 direction register
00000D	Port P5 direction register
00000E	Port P6 register
00000F	Port P7 register
000010	Port P6 direction register
000011	Port P7 direction register
000012	Port P8 register
000013	
000014	Port P8 direction register
000015	
000016	
000017	
000018	
000019	
00001A	
00001B	
00001C	Pulse output data register 1
00001D	Pulse output data register 0
00001E	A-D control register 0
00001F	A-D control register 1
000020, 000021	A-D register 0
000022, 000023	A-D register 1
000024, 000025	A-D register 2
000026, 000027	A-D register 3
000028, 000029	A-D register 4
00002A, 00002B	A-D register 5
00002C, 00002D	A-D register 6
00002E, 00002F	A-D register 7
000030	UART 0 transmit/receive mode register
000031	UART 0 baud rate register (BRG0)
000032, 000033	UART 0 transmission buffer register
000034	UART 0 transmit/receive control register 0
000035	UART 0 transmit/receive control register 1
000036, 000037	UART 0 receive buffer register
000038	UART 1 transmit/receive mode register
000039	UART 1 baud rate register (BRG1)
00003A, 00003B	UART 1 transmission buffer register
00003C	UART 1 transmit/receive control register 0
00003D	UART 1 transmit/receive control register 1
00003E, 00003F	UART 1 receive buffer register

Address (Hexadecimal notation)	
000040	Count start flag
000041	
000042	One-shot start flag
000043	
000044	Up-down flag
000045	
000046, 000047	Timer A0 register
000048, 000049	Timer A1 register
00004A, 00004B	Timer A2 register
00004C, 00004D	Timer A3 register
00004E, 00004F	Timer A4 register
000050, 000051	Timer B0 register
000052, 000053	Timer B1 register
000054, 000055	Timer B2 register
000056	Timer A0 mode register
000057	Timer A1 mode register
000058	Timer A2 mode register
000059	Timer A3 mode register
00005A	Timer A4 mode register
00005B	Timer B0 mode register
00005C	Timer B1 mode register
00005D	Timer B2 mode register
00005E	Processor mode register 0
00005F	Processor mode register 1
000060	Watchdog timer register
000061	Watchdog timer frequency selection flag
000062	Waveform output mode register
000063	Reserved area (Note)
000064	UART2 transmit/receive mode register
000065	UART2 baud rate register (BRG2)
000066, 000067	UART2 transmission buffer register
000068	UART2 transmit/receive control register 0
000069	UART2 transmit/receive control register 1
00006A, 00006B	UART2 receive buffer register
00006C	Oscillation circuit control register 0
00006D	Port function control register
00006E	Serial transmit control register
00006F	Oscillation circuit control register 1
000070	A-D/UART2 trans./rece. interrupt control register
000071	UART 0 transmission interrupt control register
000072	UART 0 receive interrupt control register
000073	UART 1 transmission interrupt control register
000074	UART 1 receive interrupt control register
000075	Timer A0 interrupt control register
000076	Timer A1 interrupt control register
000077	Timer A2 interrupt control register
000078	Timer A3 interrupt control register
000079	Timer A4 interrupt control register
00007A	Timer B0 interrupt control register
00007B	Timer B1 interrupt control register
00007C	Timer B2 interrupt control register
00007D	$\overline{INT_0}$ interrupt control register
00007E	$\overline{INT_1}$ interrupt control register
00007F	$\overline{INT_2}$/Key input interrupt control register

Note . Do not write to this address.

Fig. 2 Location of internal peripheral devices and interrupt control registers

Pulse output port mode

The pulse motor drive waveform can be output by using plural internal timer A.

Figure 3 shows a block diagram for pulse output port mode. In the pulse output port mode, two pairs of four-bit pulse output ports are used. Whether using pulse output port or not can be selected by waveform output selection bit (bit 0, bit 1) of waveform output mode register (62$_{16}$ address) shown in Figure 4. When bit 0 of waveform output selection bit is set to “1”, RTP1$_0$, RTP1$_1$, RTP1$_2$, and RTP1$_3$ are used as pulse output ports, and when bit 1 of waveform output selection bit is set to “1”, RTP0$_0$, RTP0$_1$, RTP0$_2$, and RTP0$_3$ are used as pulse output ports. When bits 1 and 0 of waveform output selection bit are set to “1”, RTP1$_0$, RTP1$_1$, RTP1$_2$, and RTP1$_3$, and RTP0$_0$, RTP0$_1$, RTP0$_2$, and RTP0$_3$ are used as pulse output ports. The ports not used as pulse output ports can be used as normal parallel ports, timer input/output or key input interrupt input.

In the pulse output port mode, set timers A0 and A2 to timer mode as timers A0 and A2 are used. Figure 5 shows the bit configuration of timer A0, A2 mode registers in pulse output port mode.

Data can be set in each bit of the pulse output data register corresponding to four ports selected as pulse output ports. Figure 6 shows the bit configuration of the pulse output data register. The contents of the pulse output data register 1 (low-order four bits of 1C$_{16}$ address) corresponding to RTP1$_0$, RTP1$_1$, RTP1$_2$, and RTP1$_3$ is output to the ports each time the counter of timer A2 becomes 0000$_{16}$. The contents of the pulse output data register 0 (low-order four bits of 1D$_{16}$ address) corresponding to RTP0$_0$, RTP0$_1$, RTP0$_2$, and RTP0$_3$ is output to the ports each time the counter of timer A0 becomes 0000$_{16}$.

Figure 7 shows example of waveforms in pulse output port mode.

When “0” is written to a specified bit of the pulse output data register, “L” level is output to the corresponding pulse output port when the counter of corresponding timer becomes 0000$_{16}$, and when “1” is written, “H” level is output to the pulse output port.

Pulse width modulation can be applied to each pulse output port. Since pulse width modulation involves the use of timers A1 and A3, activate these timers in pulse width modulation mode.

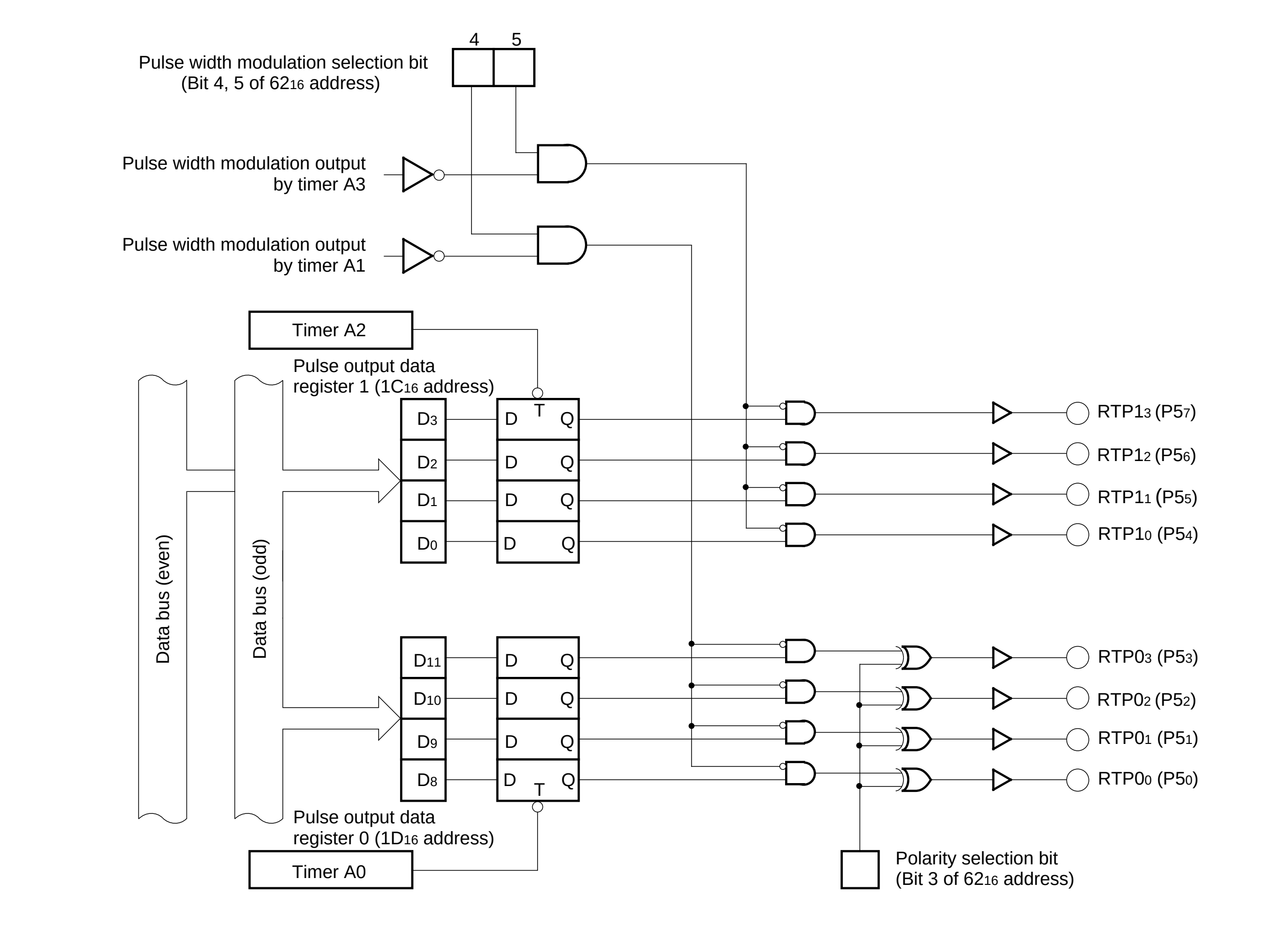


Fig. 3 Block diagram for pulse output port mode

$RTP1_0$, $RTP1_1$, $RTP1_2$, and $RTP1_3$ are applied pulse width modulation by timer A3 by setting the pulse width modulation selection bit by timer A3 (bit 5) of the waveform output mode register to “1”.
$RTP0_0$, $RTP0_1$, $RTP0_2$, and $RTP0_3$ are applied pulse width modulation by timer A1 by setting the pulse width modulation selection bit by timer A1 (bit 4) of the waveform output mode register to “1”.
The contents of the pulse output data register 0 can be reversed and output to pulse output ports $RTP0_0$, $RTP0_1$, $RTP0_2$, and $RTP0_3$ by the polarity selection bit (bit 3) of the waveform output mode register. When the polarity selection bit is “0”, the contents of the pulse output data register 0 is output unchangeably, and when “1”, the contents of the pulse output data register 0 is reversed and output. When pulse width modulation is applied, likewise the polarity reverse to pulse width modulation can be selected by the polarity selection bit.

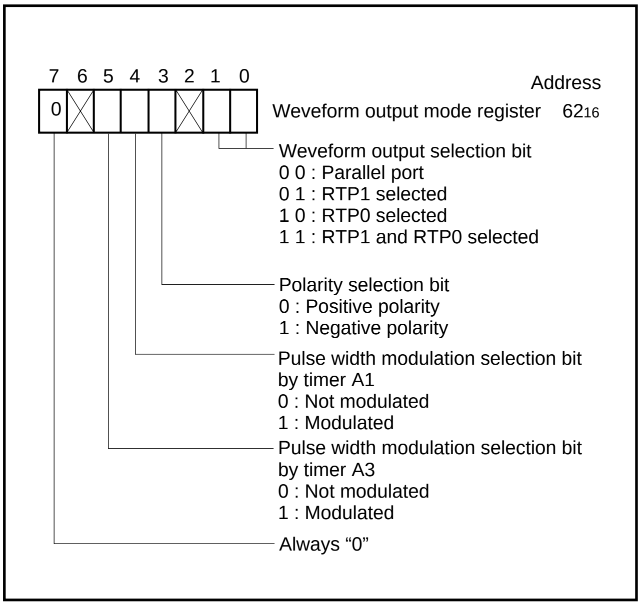


Fig. 4 Waveform output mode register bit configuration

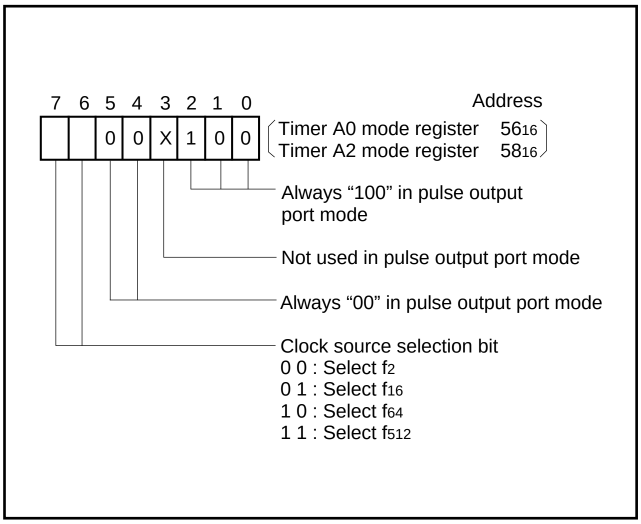


Fig. 5 Timer A0, A2 mode register bit configuration in pulse output port mode

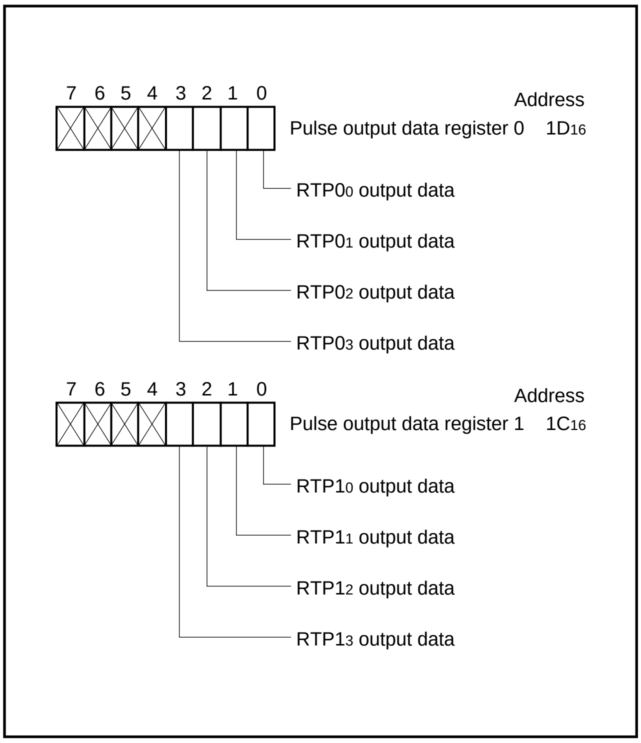


Fig. 6 Pulse output data register bit configuration

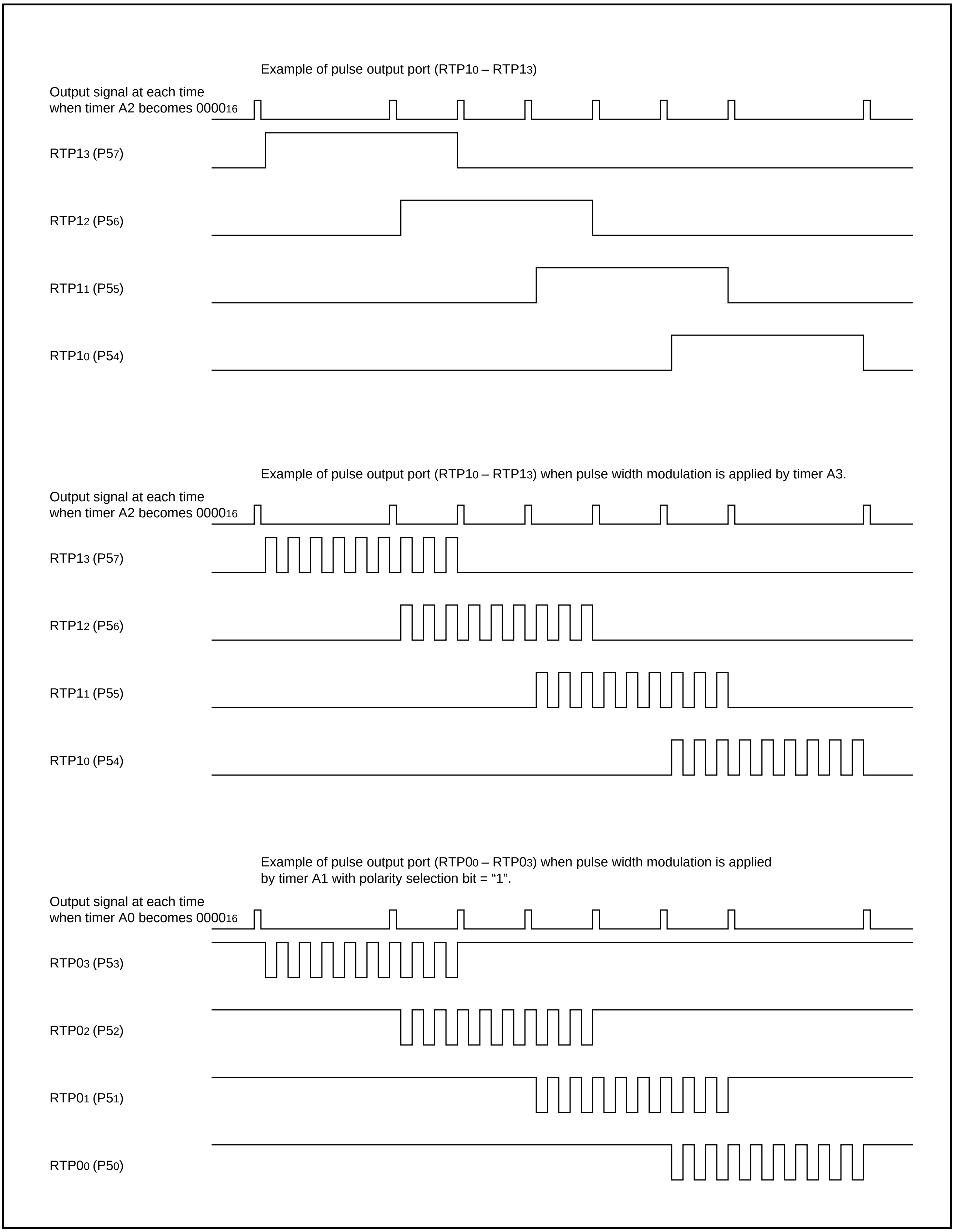


Fig. 7 Example of waveforms in pulse output port mode

PROCESSOR MODE

The bits 0 of processor mode register 0 as shown in Figure 8 is used to select which mode of microprocessor mode, and evaluation chip mode.
Figure 9 shows functions of $P0_0/A_0$ to $P4_7$ pins in each mode.
The external memory area also changes when the mode changes.
Figure 10 shows the memory map for each mode.
The accessing of the external memory is affected by the BYTE pin, the bit 2 (wait bit) of processor mode register 0, and bit 0 (wait selection bit) of processor mode register 1.

• BYTE pin

When accessing the external memory, the level of the BYTE pin is used to determine whether to use the data bus as 8-bit width or 16-bit width.
The data bus width is 8 bits when the level of the BYTE pin is “H”, and $P2_0/A_{16}/D_0$ to $P2_7/A_{23}/D_7$ pins become the data I/O pins.
The data bus width is 16 bits when the level of the BYTE pin is “L”, and both $P2_0/A_{16}/D_0$ to $P2_7/A_{23}/D_7$ pins and $P1_0/A_8/D_8$ to $P1_7/A_{15}/D_{15}$ pins become the data I/O pins.
When accessing the internal memory, the data bus width is always 16 bits regardless of the BYTE pin level.

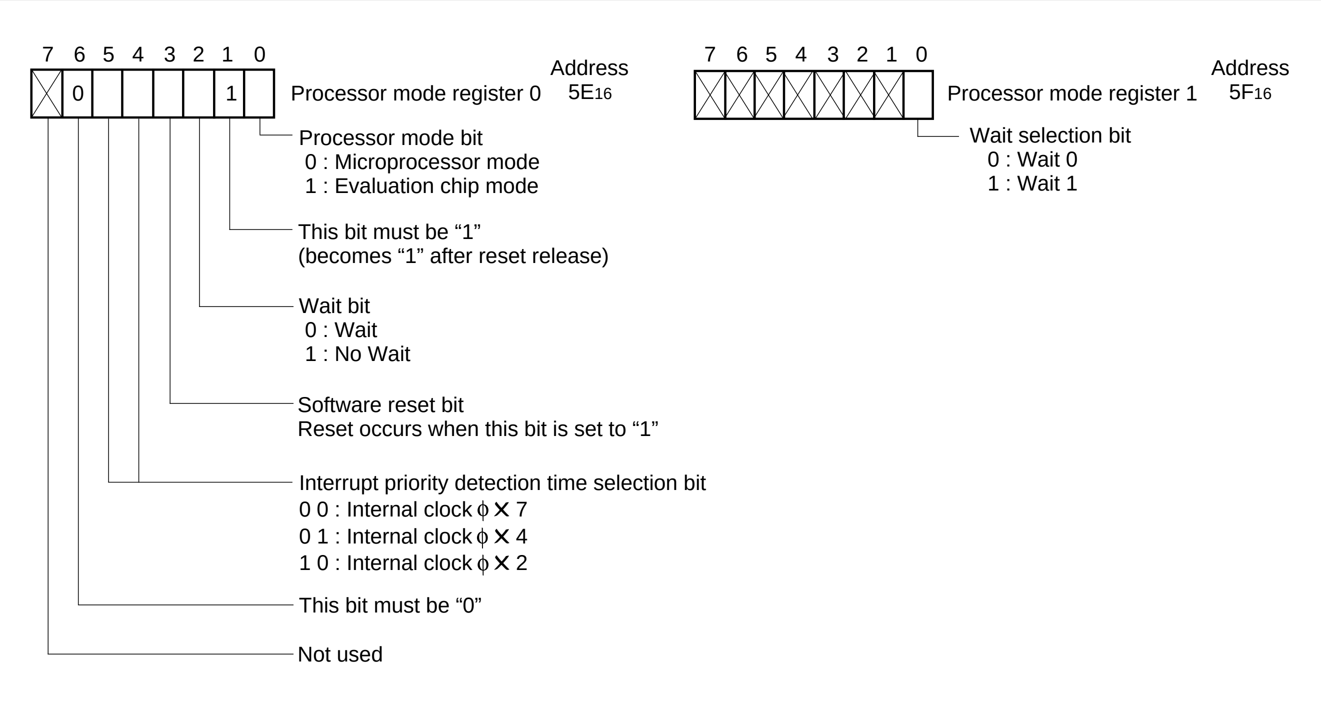


Fig. 8 Processor mode register bit configuration

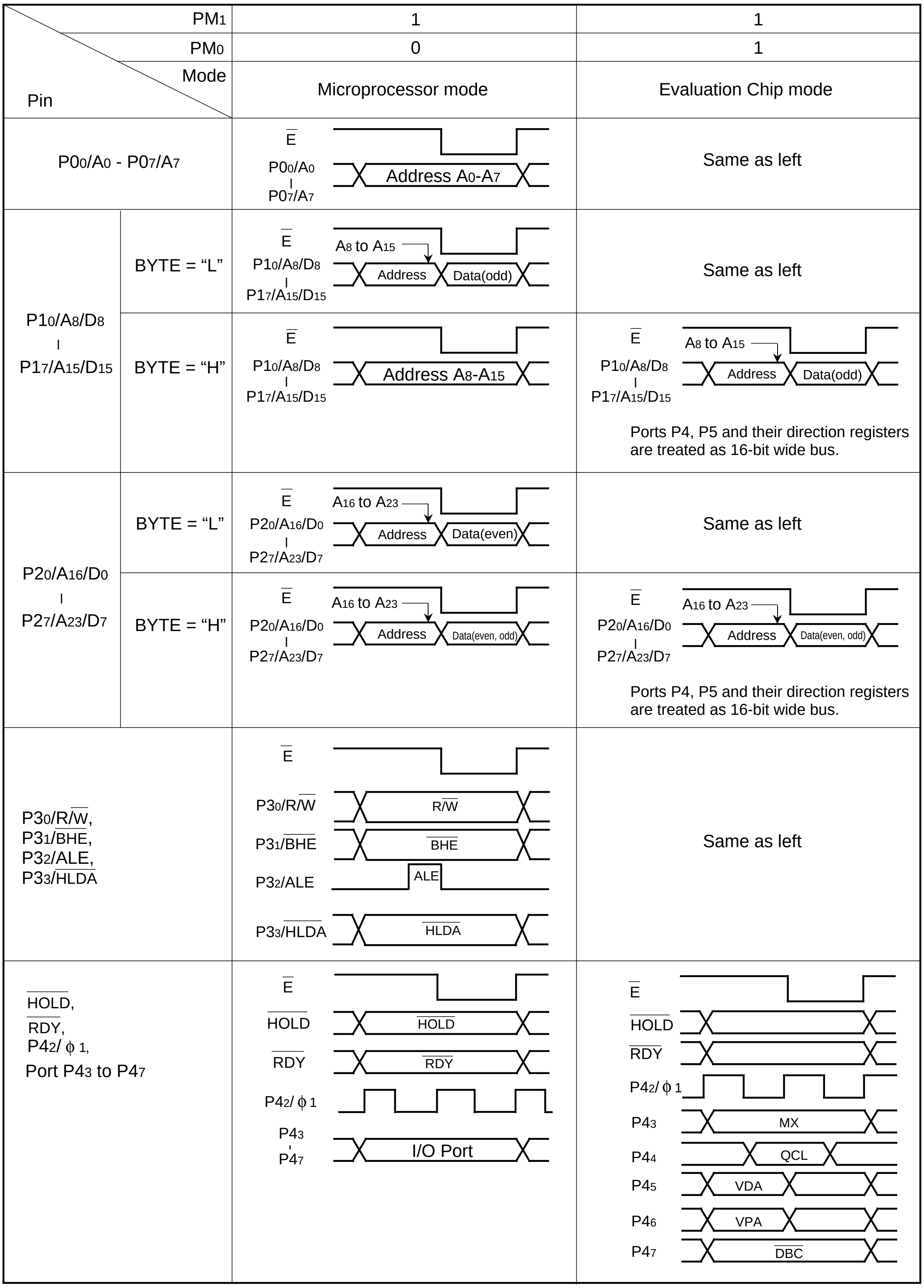
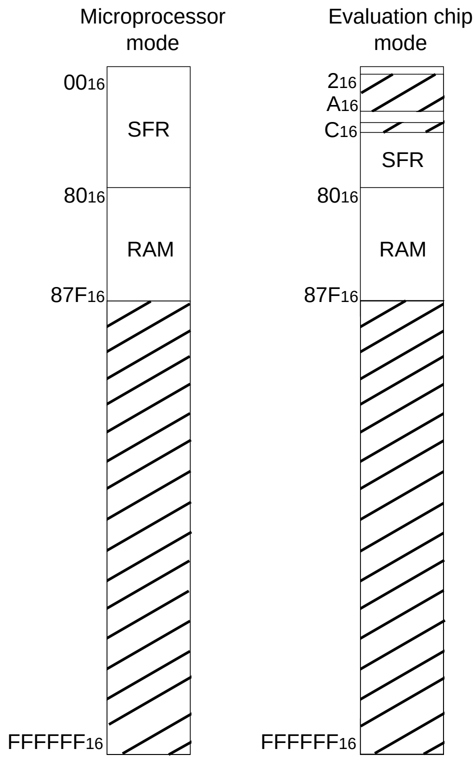


Fig. 9 Relationship between pins $P0_0$ /A_0 to $P4_7$ and processor modes

Note. The signal output disable selection bit (bit 6 of the oscillation circuit control register 0) can stop the ϕ 1 output in the microprocessor mode. In the microprocessor mode, signal $\overline{E}$ can also be fixed to "H" when the internal memory area is accessed.

• Wait bit

As shown in Figure 11, when the external memory area is accessed with the processor mode register 0 (address $5E_{16}$) bit 2 (wait bit) cleared to “0”, the access time can be extended compared with no wait (the wait bit is “1”).
The access time is extended in two ways and this is selected with bit 0 (wait selection bit) of processor mode register 1 (address $5F_{16}$). When this bit is “1”, the access time is 1.5 times compared to that for no wait. When this bit is “0”, the access time is twice compared to that for no wait.
At reset, the wait bit and the wait selection bit are “0”.
The accessing of internal memory area is performed in no wait mode regardless of the wait bit.
The processor modes are described below.



The shaded area is the external memory area.

Fig. 10 External memory area for each processor mode

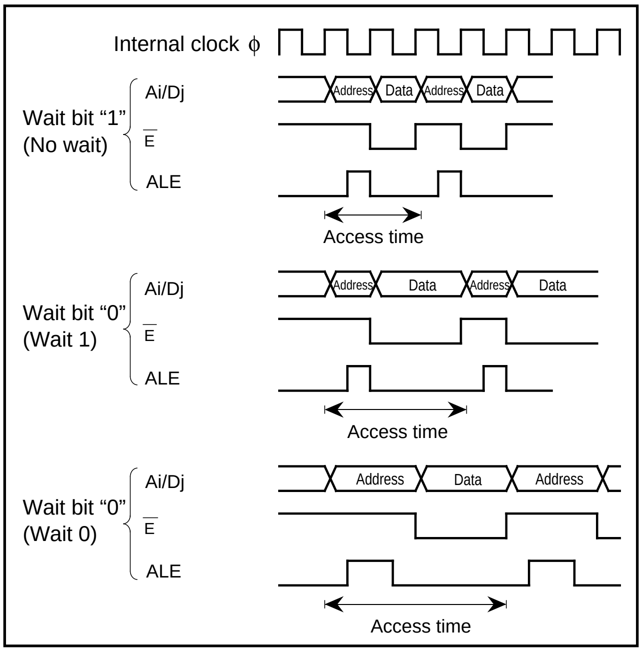


Fig. 11 Relationship between wait bit, wait selection bit, and access time

(1) Microprocessor mode [10]

Microprocessor mode is entered by connecting the CNVss pin to Vcc and starting from reset.
Signal $\overline{E}$ is output from pin $\overline{E}$ and is “L” during the data/instruction code read or data write term. When the internal memory area is read or written, $\overline{E}$ can be fixed to “H” by setting the signal output disable selection bit (bit 6 of oscillation circuit control register 0) to “1”.
$P0_0/A_0$ to $P0_7/A_7$ pins become address output pins.
$P1_0/A_8/D_8$ to $P1_7/A_{15}/D_{15}$ pins have two functions depending on the level of the BYTE pin.
When the BYTE pin level is “L”, $P1_0/A_8/D_8$ to $P1_7/A_{15}/D_{15}$ pins function as an address output pin while $\overline{E}$ is “H” and as an odd address data I/O pin while $\overline{E}$ is “L”. However, if an internal memory is read, external data is ignored while $\overline{E}$ is “L”.
When the BYTE pin level is “H”, $P1_0/A_8/D_8$ to $P1_7/A_{15}/D_{15}$ pins function as an address output pin.
When the BYTE pin level is “L”, $P2_0/A_{16}/D_0$ to $P2_7/A_{23}/D_7$ pins function as an address output pin while $\overline{E}$ is “H” and as an even address data I/O pin while $\overline{E}$ is “L”. However, if an internal memory is read, external data is ignored while $\overline{E}$ is “L”.
$R/\overline{W}$ is a read /write signal which indicates a read when it is “H” and a write when it is “L”.
$\overline{BHE}$ is a byte high enable signal which indicates that an odd address is accessed when it is “L”.
Therefore, two bytes at even and odd addresses are accessed simultaneously if address A_0 is “L” and $\overline{BHE}$ is “L”.
ALE is an address latch enable signal used to latch the address signal from a multiplexed signal of address and data. The latch is transparent while ALE is “H” to let the address signal pass through and held while ALE is “L”.

$\overline{\text{HLDA}}$ is a hold acknowledge signal and is used to notify externally when the microcomputer receives $\overline{\text{HOLD}}$ input and enters hold state.
$\overline{\text{HOLD}}$ is a hold request signal. It is an input signal used to put the microcomputer in hold state. $\overline{\text{HOLD}}$ input is accepted when the internal clock ϕ falls from "H" level to "L" level while the bus is not used. $P0_0/A_0$ to $P0_7/A_7$ pins, $P1_0/A_8/D_8$ to $P1_7/A_{15}/D_{15}$ pins, $P2_0/A_{16}/D_0$ to $P2_7/A_{23}/D_7$ pins, $P3_0/R/\overline{W}$ pin, and $P3_1/\overline{BHE}$ pin are floating while the microcomputer stays in hold state. These pins are floating after one cycle of the internal clock ϕ later than $\overline{\text{HLDA}}$ signal changes to "L" level. At the removing of hold state, these ports are removed from floating state after one cycle of internal clock ϕ later than $\overline{\text{HLDA}}$ signal changes to "H" level.
$\overline{\text{RDY}}$ is a ready signal. If this signal goes "L", the internal clock ϕ stops at "L". $\overline{\text{RDY}}$ is used when slow external memory is attached.
$P4_2/\phi_1$ pin is an output pin for clock ϕ_1. The ϕ_1 output is independent of $\overline{\text{RDY}}$ and does not stop even when internal clock ϕ stops because of "L" input to the $\overline{\text{RDY}}$ pin. As shown in Table 2, ϕ_1 output can also be stopped with the signal output disable selection bit "1". In this case, write "1" to the port $P4_2$ direction register.

(2) Evaluation chip mode [11]

Evaluation chip mode is entered by applying voltage twice the V_{CC} voltage to the CNV_{SS} pin. This mode is normally used for evaluation tools.
The functions of $\overline{E}$, $P0_0/A_0$ to $P0_7/A_7$ pins, $R/\overline{W}$, $\overline{BHE}$, ALE, and $\overline{\text{HLDA}}$ are the same as those in microprocessor mode.
$P1_0/A_8/D_8$ to $P1_7/A_{15}/D_{15}$ pins function as address output pins while $\overline{E}$ is "H" and as data I/O pin of odd addresses while $\overline{E}$ is "L" regardless of the BYTE pin level. However, if an internal memory is read, external data is ignored while $\overline{E}$ is "L". $P2_0/A_{16}/D_0$ to $P2_7/A_{23}/D_7$ pins function as address output pins while $\overline{E}$ is "H" and as data I/O pin of even addresses while $\overline{E}$ is "L" when the BYTE pin level is "L". However, if an internal memory is read, external data is ignored while $\overline{E}$ is "L".
When the BYTE pin level is "H" or 2•V_{CC}, port P2 functions as an address output pin while $\overline{E}$ is "H" and as data I/O pin of even and odd addresses while $\overline{E}$ is "L". However, if an internal memory is read, external data is ignored while $\overline{E}$ is "L".
Port P4 and its data direction which are located at address $0A_{16}$ and $0C_{16}$ are treated differently in evaluation chip mode. When these addresses are accessed, the data bus width is treated as 16 bits regardless of the BYTE pin level, and the access cycle is treated as internal memory regardless of the wait bit.
The functions of $\overline{\text{HOLD}}$ and $\overline{\text{RDY}}$ are the same as those in microprocessor mode. Clock ϕ_1 from $P4_2/\phi_1$ pin is always output regardless of signal output disable selection bit.
Ports $P4_3$ to $P4_6$ become MX, QCL, VDA, and VPA output pins respectively. Port $P4_7$ becomes the $\overline{\text{DBC}}$ input pin.
The MX signal normally contents of flag m, but the contents of flag x is output if the CPU is using flag x.
QCL is the queue buffer clear signal. It becomes "H" when the instruction queue buffer is cleared, for example, when a jump instruction is executed.
VDA is the valid data address signal. It becomes "H" while the CPU is reading data from data buffer or writing data to data buffer. It also becomes "H" when the first byte of the instruction (operation code) is read from the instruction queue buffer.
VPA is the valid program address signal. It becomes "H" while the CPU is reading an instruction code from the instruction queue buffer.
$\overline{\text{DBC}}$ is the debug control signal and is used for debugging. Table 1 shows the relationship between the CNV_{SS} pin input levels and processor modes.

Table 1. Relationship between CNVss pin input levels and processor modes

CNVss	Mode	Description
Vss	• Microprocessor (• Evaluation chip)	Microprocessor mode upon starting after reset.
2 • Vcc	• Evaluation chip	Evaluation chip mode only.

Table 2. Function of signal output disable selection bit CM_6 (bit 6 of oscillation circuit control register 0)

Processor mode	Pin	Function	
		CM_6 = "0"	CM_6 = "1"
Microprocessor mode	$\overline{E}$	$\overline{E}$ is output when the internal/external memory area is accessed.	$\overline{E}$ is output only when the external memory area is accessed.
		After WIT/STP instruction is executed, "H" is output.	"L" is output after WIT/STP instruction is executed. * Standby state selection bit (bit 0 of port function control register) must be set to "1".
	ϕ_1	Clock ϕ_1 is output.	"H"or "L" is output. (Output the content of $P4_2$ latch.) * Port $P4_2$ direction register must be set to "1".

Note. Functions shown in Table 2 cannot be emulated in a debugger.

RESET CIRCUIT

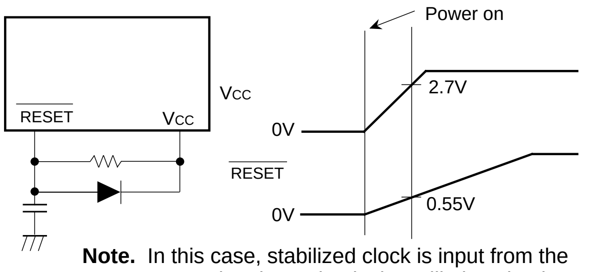
The microcomputer is released from the reset state when the $\overline{RESET}$ pin is returned to “H” level after holding it at “L” level with the power source voltage at 2.7 – 5.5 V. Program execution starts at the address formed by setting address A_{23} – A_{16} to 00_{16}, A_{15} – A_8 to the contents of address $FFFF_{16}$, and A_7 – A_0 to the contents of address $FFFE_{16}$. Figure 12 shows the status of the internal registers during reset. Figure 13 shows an example of a reset circuit. If the stabilized clock is input from the external to the main-clock oscillation circuit, the reset input voltage must be 0.55 V or less when the power source voltage reaches 2.7 V. If a resonator/oscillator is connected to the main-clock oscillation circuit, change the reset input voltage from “L” to “H” after the main-clock oscillation is fully stabilized.

Register	Address	Contents
Port P0 direction register	(04_{16})	00_{16}
Port P1 direction register	(05_{16})	00_{16}
Port P2 direction register	(08_{16})	00_{16}
Port P3 direction register	(09_{16})	× × × × 0 0 0 0
Port P4 direction register	($0C_{16}$)	00_{16}
Port P5 direction register	($0D_{16}$)	00_{16}
Port P6 direction register	(10_{16})	00_{16}
Port P7 direction register	(11_{16})	00_{16}
Port P8 direction register	(14_{16})	00_{16}
A-D control register 0	($1E_{16}$)	0 0 0 0 0 ? ? ?
A-D control register 1	($1F_{16}$)	× × 0 0 0 × 1 1
UART 0 transmit/receive mode register	(30_{16})	00_{16}
UART 1 transmit/receive mode register	(38_{16})	00_{16}
UART 0 transmit/receive control register 0	(34_{16})	0 0 0 0 1 0 0 0
UART 1 transmit/receive control register 0	($3C_{16}$)	0 0 0 0 1 0 0 0
UART 0 transmit/receive control register 1	(35_{16})	0 0 0 0 0 0 1 0
UART 1 transmit/receive control register 1	($3D_{16}$)	0 0 0 0 0 0 1 0
Count start flag	(40_{16})	00_{16}
One- shot start flag	(42_{16})	× × × 0 0 0 0 0
Up-down flag	(44_{16})	00_{16}
Timer A0 mode register	(56_{16})	00_{16}
Timer A1 mode register	(57_{16})	00_{16}
Timer A2 mode register	(58_{16})	00_{16}
Timer A3 mode register	(59_{16})	00_{16}
Timer A4 mode register	($5A_{16}$)	00_{16}
Timer B0 mode register	($5B_{16}$)	0 0 1 0 0 0 0 0
Timer B1 mode register	($5C_{16}$)	0 0 1 × 0 0 0 0
Timer B2 mode register	($5D_{16}$)	0 0 1 × 0 0 0 0
Processor mode register 0	($5E_{16}$)	00_{16}
Processor mode register 1	($5F_{16}$)	× × × × × × × 0
Watchdog timer register	(60_{16})	FFF_{16}

Register	Address	Contents
Watchdog timer frequency selection flag	(61_{16})	× × × × × × × 0
Waveform output mode register	(62_{16})	0 × 0 0 0 × 0 0
UART2 transmit/receive mode register	(64_{16})	× 0 0 0 0 0 0 0
UART2 transmit/receive control register 0	(68_{16})	× × × × 1 0 0 0
UART2 transmit/receive control register 1	(69_{16})	0 0 0 0 0 0 1 0
Oscillation circuit control register 0	($6C_{16}$)	× 0 0 0 0 0 × 1
Port function control register	($6D_{16}$)	00_{16}
Serial transmit control register	($6E_{16}$)	× × 0 0 × × × ×
Oscillation circuit control register 1	($6F_{16}$)	0 × × 0 0 0 0 0
A-D/UART2 trans./rece. interrupt control register	(70_{16})	× × × × 0 0 0 0
UART 0 transmission interrupt control register	(71_{16})	× × × × 0 0 0 0
UART 0 receive interruupt control register	(72_{16})	× × × × 0 0 0 0
UART 1 transmission interrupt control register	(73_{16})	× × × × 0 0 0 0
UART 1 receive interruupt control register	(74_{16})	× × × × 0 0 0 0
Timer A0 interrupt control register	(75_{16})	× × × × 0 0 0 0
Timer A1 interrupt control register	(76_{16})	× × × × 0 0 0 0
Timer A2 interrupt control register	(77_{16})	× × × × 0 0 0 0
Timer A3 interrupt control register	(78_{16})	× × × × 0 0 0 0
Timer A4 interrupt control register	(79_{16})	× × × × 0 0 0 0
Timer B0 interrupt control register	($7A_{16}$)	× × × × 0 0 0 0
Timer B1 interrupt control register	($7B_{16}$)	× × × × 0 0 0 0
Timer B2 interrupt control register	($7C_{16}$)	× × × × 0 0 0 0
$\overline{INT_0}$ interrupt control register	($7D_{16}$)	× × 0 0 0 0 0 0
$\overline{INT_1}$ interrupt control register	($7E_{16}$)	× × 0 0 0 0 0 0
$\overline{INT_2}$/Key input interrupt control register	($7F_{16}$)	× × 0 0 0 0 0 0
Processor status register (PS)		0 0 0 ? ? 0 0 0 1 ? ?
Program bank register (PG)		00_{16}
Program counter (PC_H)		Content of $FFFF_{16}$
Program counter (PC_L)		Content of $FFFE_{16}$
Direct page register (DPR)		0000_{16}
Data bank register (DT)		00_{16}

Contents of other registers and RAM are undefined during reset. Initialize them by software.

Fig. 12 Microcomputer internal status during reset



Note. In this case, stabilized clock is input from the external to the main-clock oscillation circuit. Perform careful evalvation at the system design level before using.

Fig. 13 Example of a reset circuit

ADDRESSING MODES

The M37733S4LHP has 28 powerful addressing modes. Refer to the MITSUBISHI SEMICONDUCTORS DATA BOOK SINGLE - CHIP 16-BIT MICROCOMPUTERS for the details of each addressing mode.

MACHINE INSTRUCTION LIST

The M37733S4LHP has 103 machine instructions. Refer to the MITSUBISHI SEMICONDUCTORS DATA BOOK SINGLE - CHIP 16-BIT MICROCOMPUTERS for details.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Conditions	Ratings	Unit
Vcc	Power source voltage		–0.3 to +7	V
AVcc	Analog power source voltage		–0.3 to +7	V
V_I	Input voltage $\overline{RESET}$, CNVss, BYTE		–0.3 to +12	V
V_I	Input voltage $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$, $P4_3 – P4_7$, $P5_0 – P5_7$, $P6_0 – P6_7$, $P7_0 – P7_7$, $P8_0 – P8_7$, V_{REF}, X_{IN}, $\overline{HOLD}$, $\overline{RDY}$		–0.3 to Vcc + 0.3	V
V_O	Output voltage $P0_0/A_0 – P0_7/A_7$, $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$, $P3_0/R/\overline{W}$, $P3_1/\overline{BHE}$, $P3_2$/ALE, $P3_3/\overline{HLDA}$, $P4_2/\phi_1$, $P4_3 – P4_7$, $P5_0 – P5_7$, $P6_0 – P6_7$, $P7_0 – P7_7$, $P8_0 – P8_7$, X_{OUT}, $\overline{E}$		–0.3 to Vcc + 0.3	V
P_d	Power dissipation	Ta = 25 °C	200	mW
T_{opr}	Operating temperature		–40 to +85	°C
T_{stg}	Storage temperature		–65 to +150	°C

RECOMMENDED OPERATING CONDITIONS (Vcc = 2.7 – 5.5 V, Ta = –40 to +85 °C, unless otherwise noted)

Symbol	Parameter		Limits			Unit
			Min.	Typ.	Max.	
Vcc	Power source voltage	$f(X_{IN})$: Operating	2.7		5.5	V
		$f(X_{IN})$: Stopped, $f(X_{CIN})$ = 32.768 kHz	2.7		5.5	
AVcc	Analog power source voltage			Vcc		V
Vss	Power source voltage			0		V
AVss	Analog power source voltage			0		V
V_{IH}	High-level input voltage $\overline{HOLD}$, $\overline{RDY}$, $P4_3 – P4_7$, $P5_0 – P5_7$, $P6_0 – P6_7$, $P7_0 – P7_7$, $P8_0 – P8_7$, X_{IN}, $\overline{RESET}$, CNVss, BYTE, X_{CIN} (Note 3)		0.8 Vcc		Vcc	V
V_{IH}	High-level input voltage $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$		0.5 Vcc		Vcc	V
V_{IL}	Low-level input voltage $\overline{HOLD}$, $\overline{RDY}$, $P4_3 – P4_7$, $P5_0 – P5_7$, $P6_0 – P6_7$, $P7_0 – P7_7$, $P8_0 – P8_7$, X_{IN}, $\overline{RESET}$, CNVss, BYTE, X_{CIN} (Note 3)		0		0.2Vcc	V
V_{IL}	Low-level input voltage $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$		0		0.16Vcc	V
$I_{OH(peak)}$	High-level peak output current $P0_0/A_0 – P0_7/A_7$, $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$, $P3_0/R/\overline{W}$, $P3_1/\overline{BHE}$, $P3_2$/ALE, $P3_3/\overline{HLDA}$, $P4_2/\phi_1$, $P4_3 – P4_7$, $P5_0 – P5_7$, $P6_0 – P6_7$, $P7_0 – P7_7$, $P8_0 – P8_7$				–10	mA
$I_{OH(avg)}$	High-level average output current $P0_0/A_0 – P0_7/A_7$, $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$, $P3_0/R/\overline{W}$, $P3_1/\overline{BHE}$, $P3_2$/ALE, $P3_3/\overline{HLDA}$, $P4_2/\phi_1$, $P4_3 – P4_7$, $P5_0 – P5_7$, $P6_0 – P6_7$, $P7_0 – P7_7$, $P8_0 – P8_7$				–5	mA
$I_{OL(peak)}$	Low-level peak output current $P0_0/A_0 – P0_7/A_7$, $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$, $P3_0/R/\overline{W}$, $P3_1/\overline{BHE}$, $P3_2$/ALE, $P3_3/\overline{HLDA}$, $P4_2/\phi_1$, $P4_3$, $P5_4 – P5_7$, $P6_0 – P6_7$, $P7_0 – P7_7$, $P8_0 – P8_7$				10	mA
$I_{OL(peak)}$	Low-level peak output current $P4_4 – P4_7$, $P5_0 – P5_3$				16	mA
$I_{OL(avg)}$	Low-level average output current $P0_0/A_0 – P0_7/A_7$, $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$, $P3_0/R/\overline{W}$, $P3_1/\overline{BHE}$, $P3_2$/ALE, $P3_3/\overline{HLDA}$, $P4_2/\phi_1$, $P4_3$, $P5_4 – P5_7$, $P6_0 – P6_7$, $P7_0 – P7_7$, $P8_0 – P8_7$				5	mA
$I_{OL(avg)}$	Low-level average output current $P4_4 – P4_7$, $P5_0 – P5_3$				12	mA
$f(X_{IN})$	Main-clock oscillation frequency (Note 4)				12	MHz
$f(X_{CIN})$	Sub-clock oscillation frequency			32.768	50	kHz

Notes 1. Average output current is the average value of a 100 ms interval.

2. The sum of $I_{OL(peak)}$ for ports $P0_0/A_0 – P0_7/A_7$, $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$, $P3_0/R/\overline{W}$, $P3_1/\overline{BHE}$, $P3_2$/ALE, $P3_3/\overline{HLDA}$ and P8 must be 80 mA or less, the sum of $I_{OH(peak)}$ for ports $P0_0/A_0 – P0_7/A_7$, $P1_0/A_8/D_8 – P1_7/A_{15}/D_{15}$, $P2_0/A_{16}/D_0 – P2_7/A_{23}/D_7$, $P3_0/R/\overline{W}$, $P3_1/\overline{BHE}$, $P3_2$/ALE, $P3_3/\overline{HLDA}$ and P8 must be 80 mA or less, the sum of $I_{OL(peak)}$ for ports P4, P5, P6, and P7 must be 100 mA or less, and the sum of $I_{OH(peak)}$ for ports P4, P5, P6, and P7 must be 80 mA or less.

3. Limits V_{IH} and V_{IL} for X_{CIN} are applied when the sub clock external input selection bit = “1”.

4. The maximum value of $f(X_{IN})$ = 6 MHz when the main clock division selection bit = “1”.

ELECTRICAL CHARACTERISTICS (Vcc = 5 V, Vss = 0 V, Ta = –40 to +85 °C, f(X_{IN}) = 12 MHz, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits Min.	Limits Typ.	Limits Max.	Unit
V_{OH}	High-level output voltage P0$_0$/A$_0$ – P0$_7$/A$_7$, P1$_0$/A$_8$/D$_8$ – P1$_7$/A$_{15}$/D$_{15}$, P2$_0$/A$_{16}$/D$_0$ – P2$_7$/A$_{23}$/D$_7$, P3$_3$/$\overline{HLDA}$, P4$_2$/ ϕ_1, P4$_3$ – P4$_7$, P5$_0$ – P5$_7$, P6$_0$ – P6$_7$, P7$_0$ – P7$_7$, P8$_0$ – P8$_7$	V_{CC} = 5 V, I_{OH} = –10 mA	3			V
		V_{CC} = 3 V, I_{OH} = –1 mA	2.5			
V_{OH}	High-level output voltage P0$_0$/A$_0$ – P0$_7$/A$_7$, P1$_0$/A$_8$/D$_8$ – P1$_7$/A$_{15}$/D$_{15}$, P2$_0$/A$_{16}$/D$_0$ – P2$_7$/A$_{23}$/D$_7$, P3$_3$/$\overline{HLDA}$, P4$_2$/ ϕ_1	V_{CC} = 5 V, I_{OH} = –400 μA	4.7			V
V_{OH}	High-level output voltage P3$_0$/R/$\overline{W}$, P3$_1$/$\overline{BHE}$, P3$_2$/ALE	V_{CC} = 5 V, I_{OH} = –10 mA	3.1			V
		V_{CC} = 5 V, I_{OH} = –400 μA	4.8			
		V_{CC} = 3 V, I_{OH} = –1 mA	2.6			
V_{OH}	High-level output voltage $\overline{E}$	V_{CC} = 5 V, I_{OH} = –10 mA	3.4			V
		V_{CC} = 5 V, I_{OH} = –400 μA	4.8			
		V_{CC} = 3 V, I_{OH} = –1 mA	2.6			
V_{OL}	Low-level output voltage P0$_0$/A$_0$ – P0$_7$/A$_7$, P1$_0$/A$_8$/D$_8$ – P1$_7$/A$_{15}$/D$_{15}$, P2$_0$/A$_{16}$/D$_0$ – P2$_7$/A$_{23}$/D$_7$, P3$_3$/$\overline{HLDA}$, P4$_2$/ ϕ_1, P4$_3$, P5$_4$ – P5$_7$, P6$_0$ – P6$_7$, P7$_0$ – P7$_7$, P8$_0$ – P8$_7$	V_{CC} = 5 V, I_{OL} = 10 mA			2	V
		V_{CC} = 3 V, I_{OL} = 1 mA			0.5	
V_{OL}	Low-level output voltage P4$_4$ – P4$_7$, P5$_0$ – P5$_3$	V_{CC} = 5 V, I_{OL} = 16 mA			1.8	V
		V_{CC} = 3 V, I_{OL} = 10 mA			1.5	
V_{OL}	Low-level output voltage P0$_0$/A$_0$ – P0$_7$/A$_7$, P1$_0$/A$_8$/D$_8$ – P1$_7$/A$_{15}$/D$_{15}$, P2$_0$/A$_{16}$/D$_0$ – P2$_7$/A$_{23}$/D$_7$, P3$_3$/$\overline{HLDA}$, P4$_2$/ ϕ_1	V_{CC} = 5 V, I_{OL} = 2 mA			0.45	V
V_{OL}	Low-level output voltage P3$_0$/R/$\overline{W}$, P3$_1$/$\overline{BHE}$, P3$_2$/ALE	V_{CC} = 5 V, I_{OL} = 10 mA			1.9	V
		V_{CC} = 5 V, I_{OL} = 2 mA			0.43	
		V_{CC} = 3 V, I_{OL} = 1 mA			0.4	
V_{OL}	Low-level output voltage $\overline{E}$	V_{CC} = 5 V, I_{OL} = 10 mA			1.6	V
		V_{CC} = 5 V, I_{OL} = 2 mA			0.4	
		V_{CC} = 3 V, I_{OL} = 1 mA			0.4	
$V_{T+} – V_{T-}$	Hysteresis $\overline{HOLD}$, $\overline{RDY}$, TA0$_{IN}$ – TA4$_{IN}$, TB0$_{IN}$ – TB2$_{IN}$, $\overline{INT_0}$ – $\overline{INT_2}$, $\overline{AD_{TRG}}$, $\overline{CTS_0}$, $\overline{CTS_1}$, $\overline{CTS_2}$, CLK$_0$, CLK$_1$, CLK$_2$, $\overline{KI_0}$ – $\overline{KI_3}$	V_{CC} = 5 V	0.4		1	V
		V_{CC} = 3 V	0.1		0.7	
$V_{T+} – V_{T-}$	Hysteresis $\overline{RESET}$	V_{CC} = 5 V	0.2		0.5	V
		V_{CC} = 3 V	0.1		0.4	
$V_{T+} – V_{T-}$	Hysteresis X_{IN}	V_{CC} = 5 V	0.1		0.4	V
		V_{CC} = 3 V	0.06		0.26	
$V_{T+} – V_{T-}$	Hysteresis X_{CIN} (When external clock is input)	V_{CC} = 5 V	0.1		0.4	V
		V_{CC} = 3 V	0.06		0.26	
I_{IH}	High-level input current P1$_0$/A$_8$/D$_8$ – P1$_7$/A$_{15}$/D$_{15}$, P2$_0$/A$_{16}$/D$_0$ – P2$_7$/A$_{23}$/D$_7$, P4$_3$ – P4$_7$, P5$_0$ – P5$_7$, P6$_0$ – P6$_7$, P7$_0$ – P7$_7$, P8$_0$ – P8$_7$, X_{IN}, $\overline{RESET}$, CNVss, BYTE	V_{CC} = 5 V, V_I = 5 V			5	μA
		V_{CC} = 3 V, V_I = 3 V			4	
I_{IL}	Low-level input current P1$_0$/A$_8$/D$_8$ – P1$_7$/A$_{15}$/D$_{15}$, P2$_0$/A$_{16}$/D$_0$ – P2$_7$/A$_{23}$/D$_7$, P4$_3$ – P4$_7$, P5$_0$ – P5$_3$, P6$_0$, P6$_1$, P6$_5$ – P6$_7$, P7$_0$ – P7$_7$, P8$_0$ – P8$_7$, X_{IN}, $\overline{RESET}$, CNVss, BYTE	V_{CC} = 5 V, V_I = 0 V			–5	μA
		V_{CC} = 3 V, V_I = 0 V			–4	
I_{IL}	Low-level input current P5$_4$ – P5$_7$, P6$_2$ – P6$_4$	V_I = 0 V, without a pull-up transistor, V_{CC} = 5 V			–5	μA
		V_I = 0 V, without a pull-up transistor, V_{CC} = 3 V			–4	
		V_I = 0 V, with a pull-up transistor, V_{CC} = 5 V	–0.25	–0.5	–1.0	mA
		V_I = 0 V, with a pull-up transistor, V_{CC} = 3 V	–0.08	–0.18	–0.35	
V_{RAM}	RAM hold voltage	When clock is stopped	2			V

ELECTRICAL CHARACTERISTICS (Vcc = 5 V, Vss = 0 V, Ta = –40 to +85 °C, unless otherwise noted)

Symbol	Parameter	Test conditions		Limits Min.	Typ.	Max.	Unit
ICC	Power source current	When external bus is in use, output pins are open, and other pins are VSS.	VCC = 5 V, f(XIN) = 12 MHz (square waveform), (f(f2) = 6 MHz), f(XCIN) = 32.768 kHz, in operating (Note 1)		5.4	10.8	mA
			VCC = 3 V, f(XIN) = 12 MHz (square waveform), (f(f2) = 6 MHz), f(XCIN) = 32.768 kHz, in operating (Note 1)		3.6	7.2	mA
			VCC = 3 V, f(XIN) = 12 MHz (square waveform), (f(f2) = 0.75 MHz), f(XCIN) = Stopped, in operating		0.5	1.0	mA
			VCC = 3 V, f(XIN) = 12 MHz (square waveform), f(XCIN) = 32.768 kHz, when a WIT instruction is executed (Note 2)		6	12	μA
			VCC = 3 V, f(XIN) = Stopped, f(XCIN) = 32.768 kHz, in operating (Note 3)		40	80	μA
			VCC = 3 V, f(XIN) = Stopped, f(XCIN) = 32.768 kHz, when a WIT instruction is executed (Note 4)		3	6	μA
			Ta = 25 °C, when clock is stopped			1	μA
			Ta = 85 °C, when clock is stopped			20	μA

Notes 1. This applies when the main clock external input selection bit = "1", the main clock division selection bit = "0", and the signal output stop bit = "1".
2. This applies when the main clock external input selection bit = "1" and the system clock stop bit at wait state = "1".
3. This applies when CPU and the clock timer are operating with the sub clock (32.768 kHz) selected as the system clock.
4. This applies when the XCOUT drivability selection bit = "0" and the system clock stop bit at wait state = "1".

A–D CONVERTER CHARACTERISTICS

(VCC = AVCC = 5 V, VSS = AVSS = 0 V, Ta = –40 to +85 °C, f(XIN) = 12 MHz, unless otherwise noted (Note))

Symbol	Parameter	Test conditions	Limits Min.	Typ.	Max.	Unit
—	Resolution	VREF = VCC			10	Bits
—	Absolute accuracy	VREF = VCC			± 3	LSB
RLADDER	Ladder resistance	VREF = VCC	10		25	kΩ
tCONV	Conversion time		19.6			μs
VREF	Reference voltage		2.7		VCC	V
VIA	Analog input voltage		0		VREF	V

Note. This applies when the main clock division selection bit = "0" and f(f2) = 6 MHz.

TIMING REQUIREMENTS (V_{CC} = 2.7 – 5.5 V , V_{SS} = 0 V, Ta = –40 to +85 °C, f(X_{IN}) = 12 MHz, unless otherwise noted (Note 1))
Notes 1. This applies when the main clock division selection bit = “0” and f(f_2) = 6 MHz.
2. Input signal’s rise/fall time must be 100 ns or less, unless otherwise noted.

External clock input

Symbol	Parameter	Limits		Unit
		Min.	Max.	
t_c	External clock input cycle time (Note 1)	83		ns
$t_{w(H)}$	External clock input high-level pulse width (Note 2)	33		ns
$t_{w(L)}$	External clock input low-level pulse width (Note 2)	33		ns
t_r	External clock rise time		15	ns
t_f	External clock fall time		15	ns

Notes 1. When the main clock division selection bit = “1”, the minimum value of tc = 166 ns.
2. When the main clock division selection bit = “1”, values of $t_{w(H)}$ / tc and $t_{w(L)}$ / tc must be set to values from 0.45 through 0.55.

Microprocessor mode

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{su(P4D-E)}$	Port P4 input setup time	200		ns
$t_{su(P5D-E)}$	Port P5 input setup time	200		ns
$t_{su(P6D-E)}$	Port P6 input setup time	200		ns
$t_{su(P7D-E)}$	Port P7 input setup time	200		ns
$t_{su(P8D-E)}$	Port P8 input setup time	200		ns
$t_{h(E-P4D)}$	Port P4 input hold time	0		ns
$t_{h(E-P5D)}$	Port P5 input hold time	0		ns
$t_{h(E-P6D)}$	Port P6 input hold time	0		ns
$t_{h(E-P7D)}$	Port P7 input hold time	0		ns
$t_{h(E-P8D)}$	Port P8 input hold time	0		ns
$t_{su(D-E)}$	Data input setup time	80		ns
$t_{su(RDY-\phi 1)}$	$\overline{\text{RDY}}$ input setup time	80		ns
$t_{su(HOLD-\phi 1)}$	$\overline{\text{HOLD}}$ input setup time	80		ns
$t_{h(E-D)}$	Data input hold time	0		ns
$t_{h(\phi 1-RDY)}$	$\overline{\text{RDY}}$ input hold time	0		ns
$t_{h(\phi 1-HOLD)}$	$\overline{\text{HOLD}}$ input hold time	0		ns

Timer A input (Count input in event counter mode)

Symbol	parameter	Limits		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} input cycle time	250		ns
$t_{w(TAH)}$	TAi_{IN} input high-level pulse width	125		ns
$t_{w(TAL)}$	TAi_{IN} input low-level pulse width	125		ns

Timer A input (Gating input in timer mode)

Symbol	parameter	Limits		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} input cycle time (Note)	666		ns
$t_{w(TAH)}$	TAi_{IN} input high-level pulse width (Note)	333		ns
$t_{w(TAL)}$	TAi_{IN} input low-level pulse width (Note)	333		ns

Note. Limits change depending on $f(X_{IN})$. Refer to "DATA FORMULAS."

Timer A input (External trigger input in one-shot pulse mode)

Symbol	parameter	Limits		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} input cycle time (Note)	666		ns
$t_{w(TAH)}$	TAi_{IN} input high-level pulse width	166		ns
$t_{w(TAL)}$	TAi_{IN} input low-level pulse width	166		ns

Note. Limits change depending on $f(X_{IN})$. Refer to "DATA FORMULAS."

Timer A input (External trigger input in pulse width modulation mode)

Symbol	parameter	Limits		Unit
		Min.	Max.	
$t_{w(TAH)}$	TAi_{IN} input high-level pulse width	166		ns
$t_{w(TAL)}$	TAi_{IN} input low-level pulse width	166		ns

Timer A input (Up-down input in event counter mode)

Symbol	parameter	Limits		Unit
		Min.	Max.	
$t_{c(UP)}$	TAi_{OUT} input cycle time	3333		ns
$t_{w(UPH)}$	TAi_{OUT} input high-level pulse width	1666		ns
$t_{w(UPL)}$	TAi_{OUT} input low-level pulse width	1666		ns
$t_{su(UP-T_{IN})}$	TAi_{OUT} input setup time	666		ns
$t_{h(T_{IN}-UP)}$	TAi_{OUT} input hold time	666		ns

Timer A input (Two-phase pulse input in event counter mode)

Symbol	parameter	Limits		Unit
		Min.	Max.	
$t_{c(TA)}$	TAj_{IN} input cycle time	2000		ns
$t_{su(TAj_{IN}-TAj_{OUT})}$	TAj_{IN} input setup time	500		ns
$t_{su(TAj_{OUT}-TAj_{IN})}$	TAj_{OUT} input setup time	500		ns

Timer B input (Count input in event counter mode)

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} input cycle time (one edge count)	250		ns
$t_{w(TBH)}$	TBi_{IN} input high-level pulse width (one edge count)	125		ns
$t_{w(TBL)}$	TBi_{IN} input low-level pulse width (one edge count)	125		ns
$t_{c(TB)}$	TBi_{IN} input cycle time (both edges count)	500		ns
$t_{w(TBH)}$	TBi_{IN} input high-level pulse width (both edges count)	250		ns
$t_{w(TBL)}$	TBi_{IN} input low-level pulse width (both edges count)	250		ns

Timer B input (Pulse period measurement mode)

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} input cycle time (Note)	666		ns
$t_{w(TBH)}$	TBi_{IN} input high-level pulse width (Note)	333		ns
$t_{w(TBL)}$	TBi_{IN} input low-level pulse width (Note)	333		ns

Note. Limits change depending on $f(X_{IN})$. Refer to “DATA FORMULAS.”

Timer B input (Pulse width measurement mode)

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} input cycle time (Note)	666		ns
$t_{w(TBH)}$	TBi_{IN} input high-level pulse width (Note)	333		ns
$t_{w(TBL)}$	TBi_{IN} input low-level pulse width (Note)	333		ns

Note. Limits change depending on $f(X_{IN})$. Refer to “DATA FORMULAS.”

A-D trigger input

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{c(AD)}$	$\overline{AD_{TRG}}$ input cycle time (minimum allowable trigger)	1333		ns
$t_{w(ADL)}$	$\overline{AD_{TRG}}$ input low-level pulse width	166		ns

Serial I/O

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{c(CK)}$	CLK_i input cycle time	333		ns
$t_{w(CKH)}$	CLK_i input high-level pulse width	166		ns
$t_{w(CKL)}$	CLK_i input low-level pulse width	166		ns
$t_{d(C-Q)}$	TxD_i output delay time		100	ns
$t_{h(C-Q)}$	TxD_i hold time	0		ns
$t_{su(D-C)}$	RxD_i input setup time	65		ns
$t_{h(C-D)}$	RxD_i input hold time	75		ns

External interrupt $\overline{INT_i}$ input, key input interrupt $\overline{KI_i}$ input

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{w(INH)}$	$\overline{INT_i}$ input high-level pulse width	250		ns
$t_{w(INL)}$	$\overline{INT_i}$ input low-level pulse width	250		ns
$t_{w(KIL)}$	$\overline{KI_i}$ input low-level pulse width	250		ns

DATA FORMULAS

Timer A input (Gating input in timer mode)

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} input cycle time	$\frac{8 \times 10^9}{2 \cdot f(f_2)}$		ns
$t_{w(TAH)}$	TAi_{IN} input high-level pulse width	$\frac{4 \times 10^9}{2 \cdot f(f_2)}$		ns
$t_{w(TAL)}$	TAi_{IN} input low-level pulse width	$\frac{4 \times 10^9}{2 \cdot f(f_2)}$		ns

Timer A input (External trigger input in one-shot pulse mode)

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} input cycle time	$\frac{8 \times 10^9}{2 \cdot f(f_2)}$		ns

Timer B input (In pulse period measurement mode or pulse width measurement mode)

Symbol	Parameter	Limits		Unit
		Min.	Max.	
$t_{c(TB)}$	TBi_{IN} input cycle time	$\frac{8 \times 10^9}{2 \cdot f(f_2)}$		ns
$t_{w(TBH)}$	TBi_{IN} input high-level pulse width	$\frac{4 \times 10^9}{2 \cdot f(f_2)}$		ns
$t_{w(TBL)}$	TBi_{IN} input low-level pulse width	$\frac{4 \times 10^9}{2 \cdot f(f_2)}$		ns

Note. $f(f_2)$ expresses the clock f_2 frequency.
For the relation to the main clock and sub clock, refer to Table 9 in data sheet “M37733MHBXXXFP”.

SWITCHING CHARACTERISTICS

(V_{CC} = 2.7 – 5.5 V, V_{SS} = 0 V, Ta = –40 to +85°C, f(X_{IN}) = 12 MHz, unless otherwise noted (Note))

Microprocessor mode

Symbol	Parameter	Test conditions	Limits		Unit
			Min.	Max.	
$t_{d(E-P4Q)}$	Port P4 data output delay time	Fig. 14		300	ns
$t_{d(E-P5Q)}$	Port P5 data output delay time			300	ns
$t_{d(E-P6Q)}$	Port P6 data output delay time			300	ns
$t_{d(E-P7Q)}$	Port P7 data output delay time			300	ns
$t_{d(E-P8Q)}$	Port P8 data output delay time			300	ns

Note. This applies when the main clock division selection bit = “0” and f(f_2) = 6 MHz.

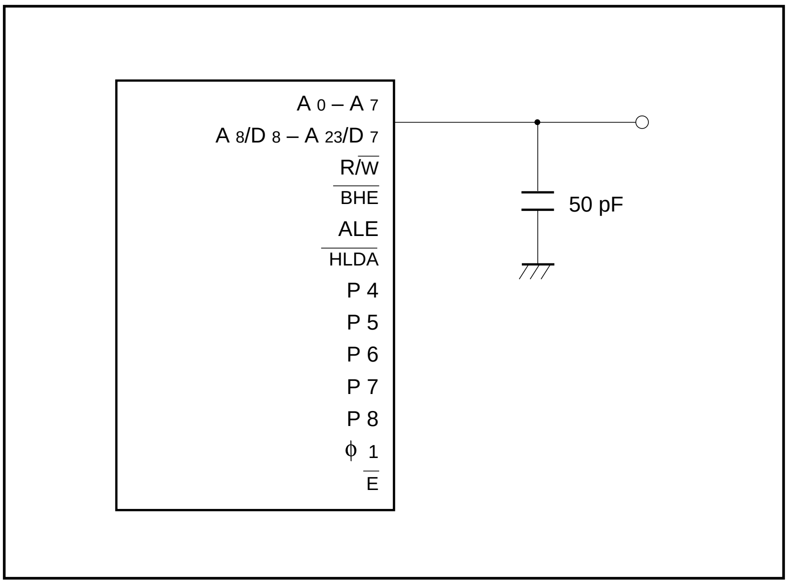


Fig. 14 Measuring circuit for each pin

Microprocessor mode

(V_{CC} = 2.7 – 5.5 V, V_{SS} = 0 V, Ta = –40 to +85 °C, f(X_{IN}) = 12 MHz, unless otherwise noted (Note 1))

Symbol	Parameter	Wait mode (Note2)	Test conditions	Limits Min.	Limits Max.	Unit
$t_{d(An-E)}$	Address output delay time	No wait Wait 1	Fig. 14	20		ns
		Wait 0		182		ns
$t_{d(A-E)}$	Address output delay time	No wait Wait 1		20		ns
		Wait 0		162		ns
$t_{h(E-An)}$	Address hold time			40		ns
$t_{w(ALE)}$	ALE pulse width	No wait Wait 1		40		ns
		Wait 0		123		ns
$t_{su(A-ALE)}$	Address output setup time	No wait Wait 1		10		ns
		Wait 0		93		ns
$t_{h(ALE-A)}$	Address hold time	No wait Wait 1		9		ns
		Wait 0		40		ns
$t_{d(ALE-E)}$	ALE output delay time	No wait Wait 1		4		ns
		Wait 0		40		ns
$t_{d(E-DQ)}$	Data output delay time				90	ns
$t_{h(E-DQ)}$	Data hold time			40		ns
$t_{w(EL)}$	$\overline{E}$ pulse width	No wait		131		ns
		Wait 1 Wait 0		298		ns
$t_{pxz(E-DZ)}$	Floating start delay time				10	ns
$t_{pzx(E-DZ)}$	Floating release delay time			53		ns
$t_{d(BHE-E)}$	$\overline{BHE}$ output delay time	No wait Wait 1		20		ns
		Wait 0		182		ns
$t_{d(R/W-E)}$	R/$\overline{W}$ output delay time	No wait Wait 1		20		ns
		Wait 0		182		ns
$t_{h(E-BHE)}$	$\overline{BHE}$ hold time			33		ns
$t_{h(E-R/W)}$	R/$\overline{W}$ hold time			33		ns
$t_{d(E-\phi 1)}$	ϕ_1 output delay time			0	30	ns
$t_{d(\phi 1-HLDA)}$	$\overline{HLDA}$ output delay time				120	ns

Notes 1. This applies when the main clock division selection bit = “0” and f(f_2) = 6 MHz.

2. No wait : Wait bit = “1”.
Wait 1 : The external memory area is accessed with wait bit = “0” and wait selection bit = “1”.
Wait 0 : The external memory area is accessed with wait bit = “0” and wait selection bit = “0”.

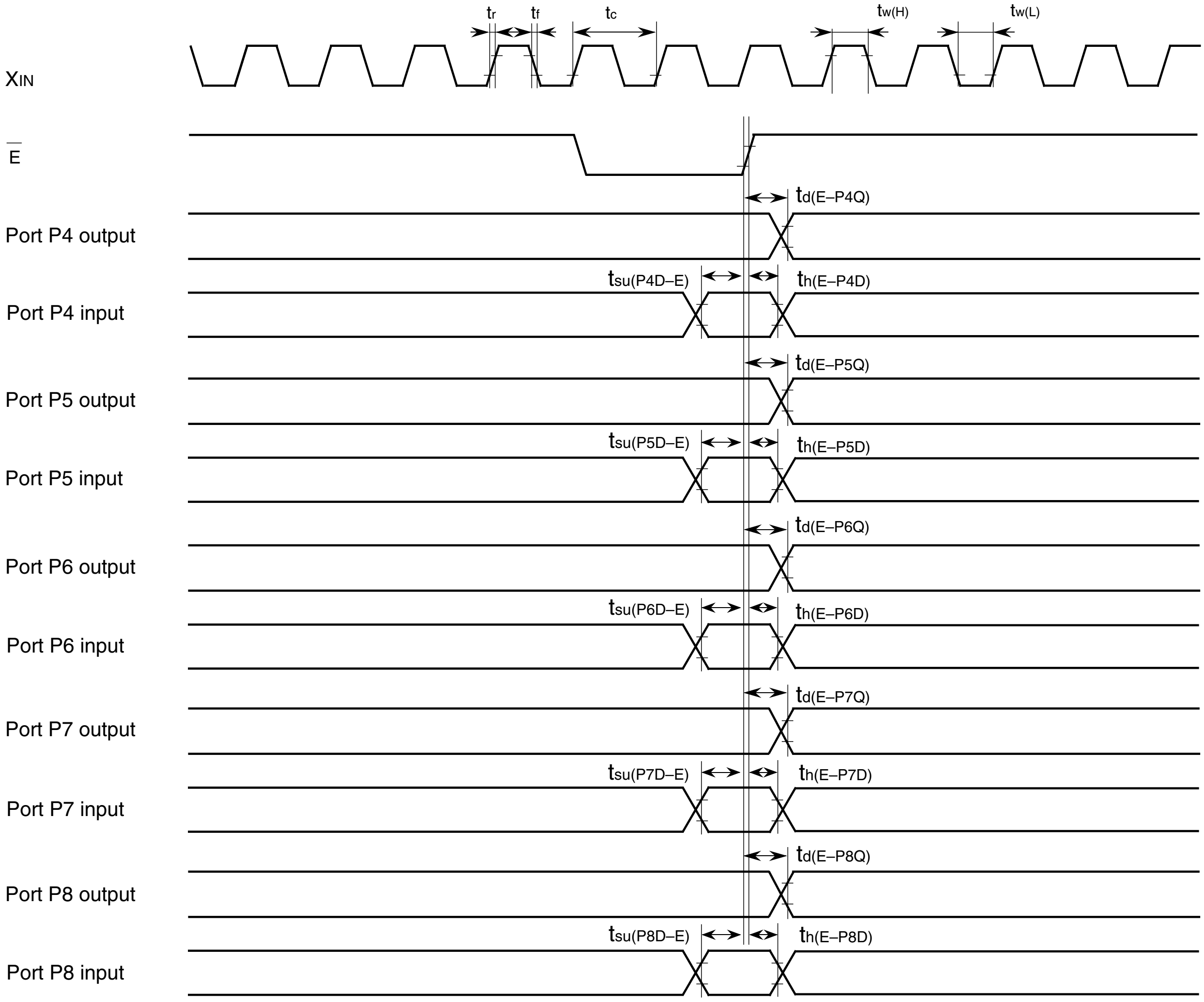
Bus timing data formulas

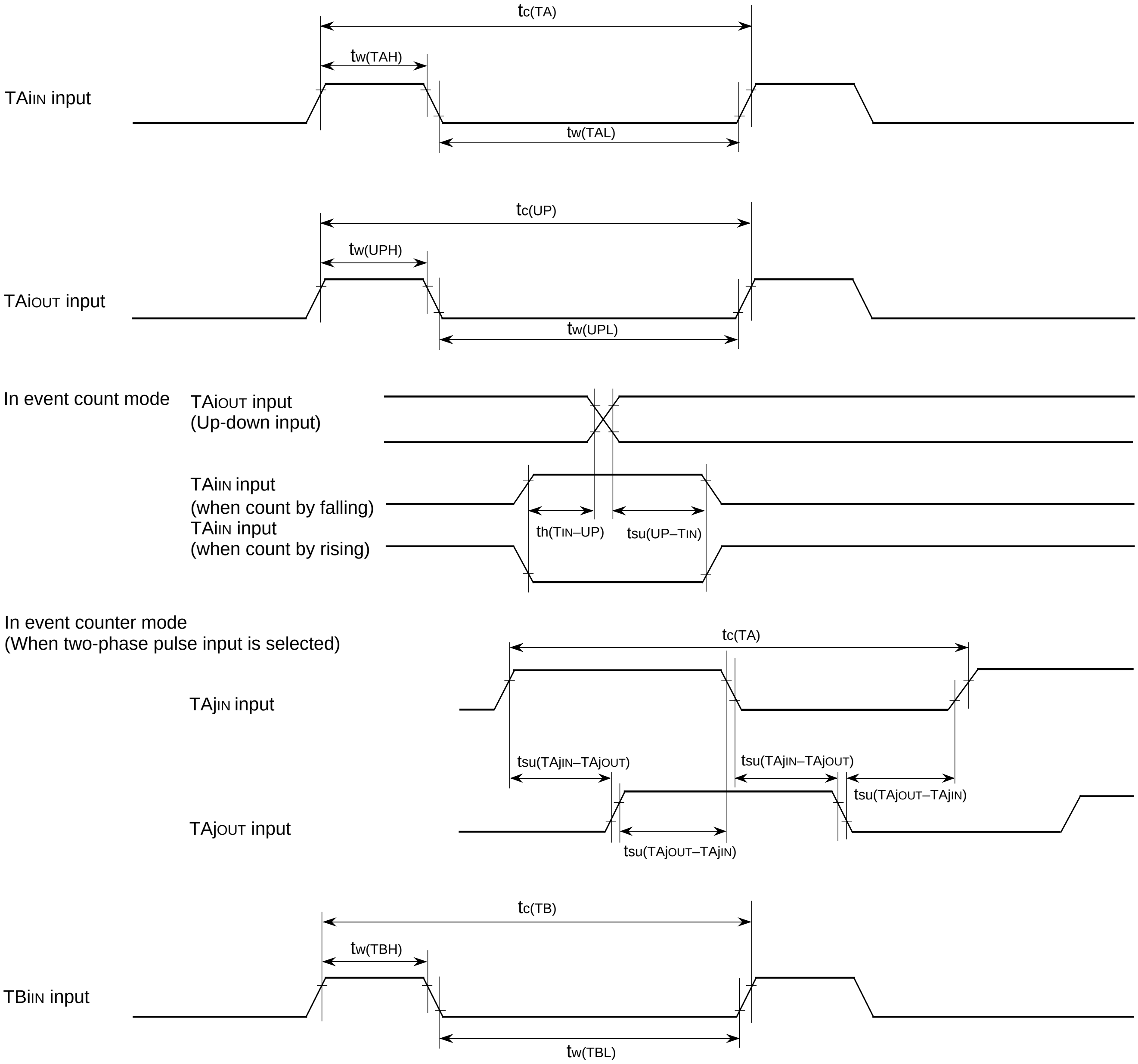
(V_{CC} = 2.7 – 5.5 V, V_{SS} = 0 V, Ta = –40 to +85 °C, f(X_{IN}) = 12 MHz (Max.), unless otherwise noted (Note 1))

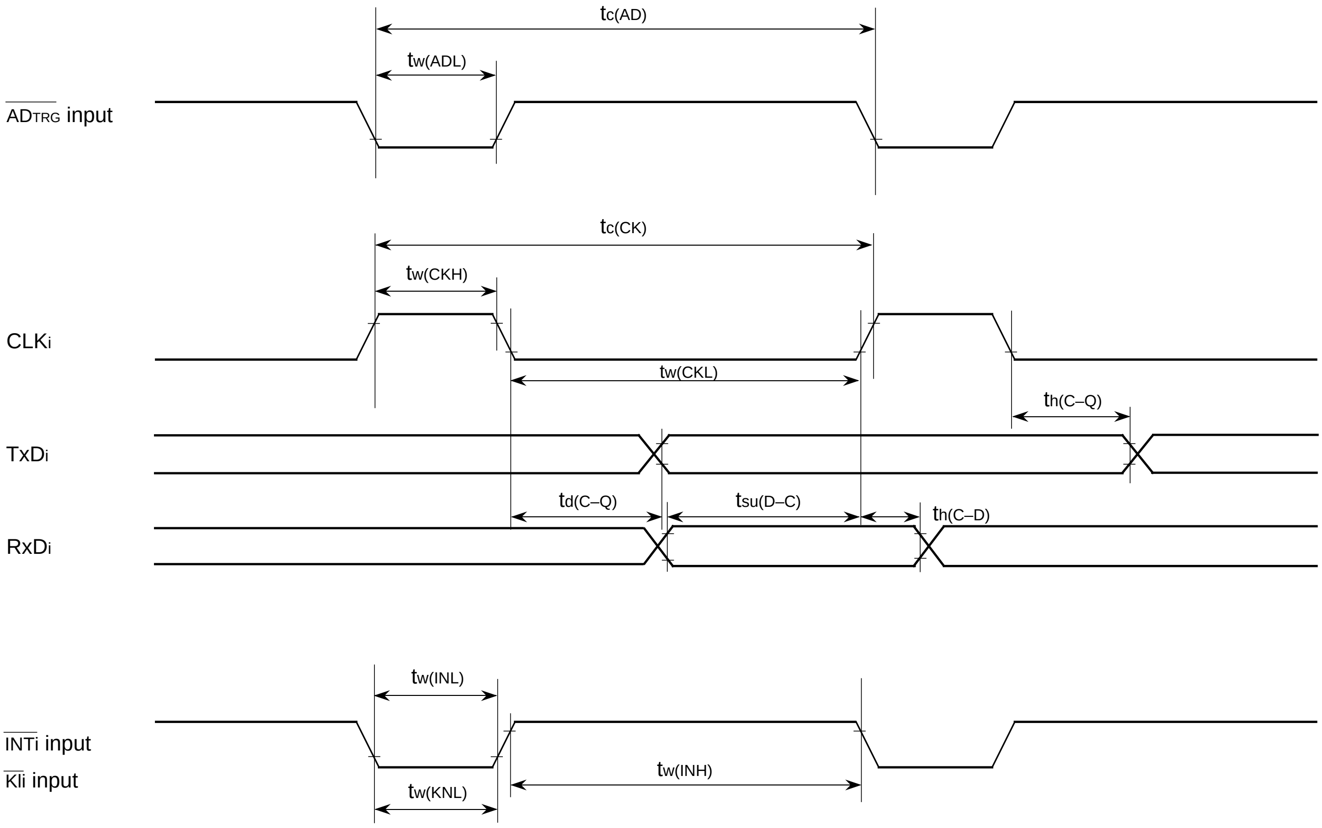
Symbol	Parameter		Limits		Unit
		Wait mode	Min.	Max.	
$t_{d(An-E)}$	Address output delay time	No wait Wait 1	$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 63$		ns
		Wait 0	$\frac{3 \times 10^9}{2 \cdot f(f_2)} - 68$		ns
$t_{d(A-E)}$	Address output delay time	No wait Wait 1	$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 63$		ns
		Wait 0	$\frac{3 \times 10^9}{2 \cdot f(f_2)} - 88$		ns
$t_{h(E-An)}$	Address hold time		$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 43$		ns
$t_{w(ALE)}$	ALE pulse width	No wait Wait 1	$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 43$		ns
		Wait 0	$\frac{2 \times 10^9}{2 \cdot f(f_2)} - 43$		ns
$t_{su(A-ALE)}$	Address output setup time	No wait Wait 1	$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 73$		ns
		Wait 0	$\frac{2 \times 10^9}{2 \cdot f(f_2)} - 73$		ns
$t_{h(ALE-A)}$	Address hold time	No wait Wait 1	9		ns
		Wait 0	$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 43$		ns
$t_{d(ALE-E)}$	ALE output delay time	No wait Wait 1	4		ns
		Wait 0	$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 43$		ns
$t_{d(E-DQ)}$	Data output delay time			90	ns
$t_{h(E-DQ)}$	Data hold time		$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 43$		ns
$t_{w(EL)}$	$\overline{E}$ pulse width	No wait	$\frac{2 \times 10^9}{2 \cdot f(f_2)} - 35$		ns
		Wait 1 Wait 0	$\frac{4 \times 10^9}{2 \cdot f(f_2)} - 35$		ns
$t_{pxz(E-DZ)}$	Floating start delay time			10	ns
$t_{pzx(E-DZ)}$	Floating release delay time		$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 30$		ns
$t_{d(BHE-E)}$	$\overline{BHE}$ output delay time	No wait Wait 1	$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 63$		ns
		Wait 0	$\frac{3 \times 10^9}{2 \cdot f(f_2)} - 68$		ns
$t_{d(R/W-E)}$	R/$\overline{W}$ output delay time	No wait Wait 1	$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 63$		ns
		Wait 0	$\frac{3 \times 10^9}{2 \cdot f(f_2)} - 68$		ns
$t_{h(E-BHE)}$	$\overline{BHE}$ hold time		$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 50$		ns
$t_{h(E-R/W)}$	R/$\overline{W}$ hold time		$\frac{1 \times 10^9}{2 \cdot f(f_2)} - 50$		ns
$t_{d(E-\phi 1)}$	ϕ_1 output delay time		0	30	ns

Notes 1. This applies when the main-clock division selection bit = “0”.
2. f(f_2) expresses the clock f_2 frequency.
For the relation to the main clock and sub clock, refer to Table 9 in data sheet “M37733MHBXXXFP”.

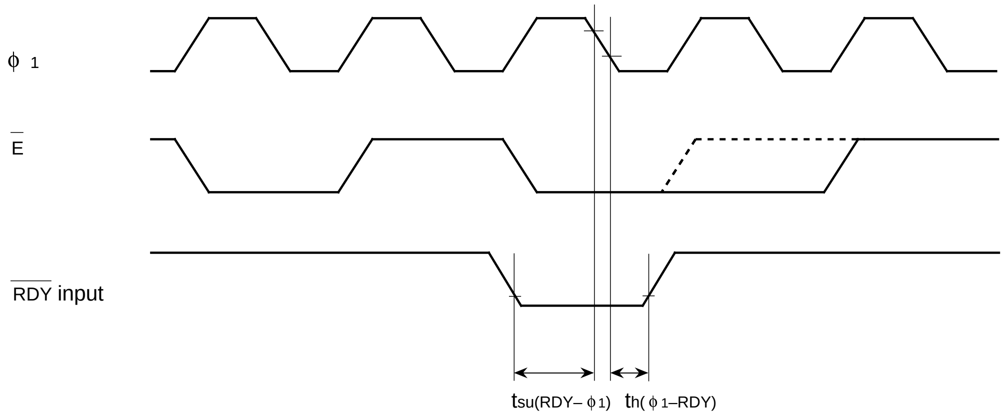
TIMING DIAGRAM



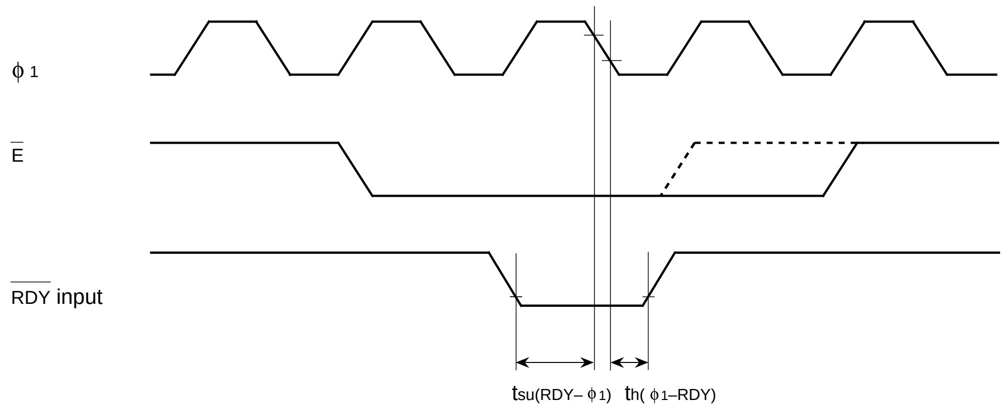

tc(TA)
tw(TAH)
TAiIN input
tw(TAL)
tc(UP)
tw(UPH)
TAiOUT input
tw(UPL)
In event count mode
TAiOUT input
(Up-down input)
TAiIN input
(when count by falling)
TAiIN input
(when count by rising)
th(TIN–UP)
tsu(UP–TIN)
In event counter mode
(When two-phase pulse input is selected)
tc(TA)
TAjIN input
tsu(TAjIN–TAjOUT)
tsu(TAjIN–TAjOUT)
tsu(TAjOUT–TAjIN)
TAjOUT input
tsu(TAjOUT–TAjIN)
tc(TB)
tw(TBH)
TBiIN input
tw(TBL)


tc(AD)
tw(ADL)
ADTRG input
tc(CK)
tw(CKH)
CLKi
tw(CKL)
th(C–Q)
TxDi
td(C–Q)
tsu(D–C)
th(C–D)
RxDi
tw(INL)
INTi input
KIi input
tw(INH)
tw(KNL)

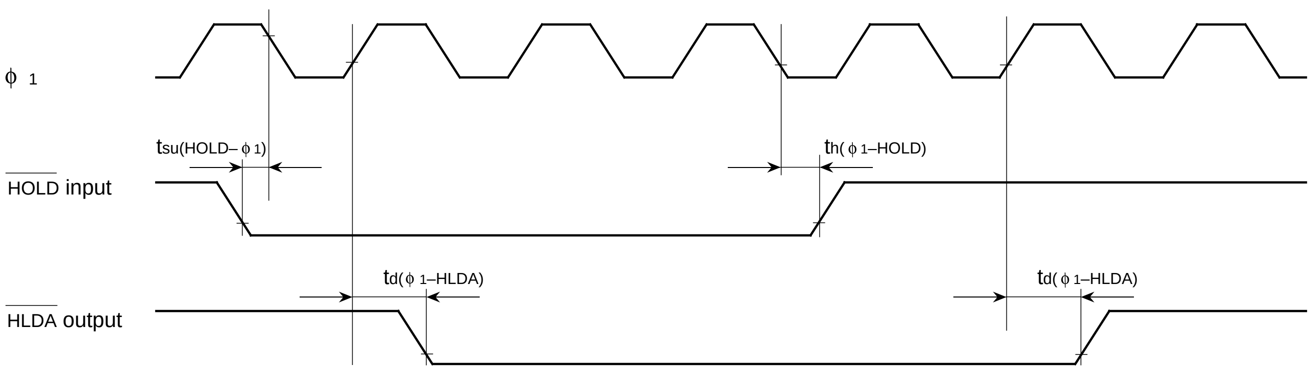
Microprocessor mode
(When wait bit = “1”)



(When wait bit = “0”)

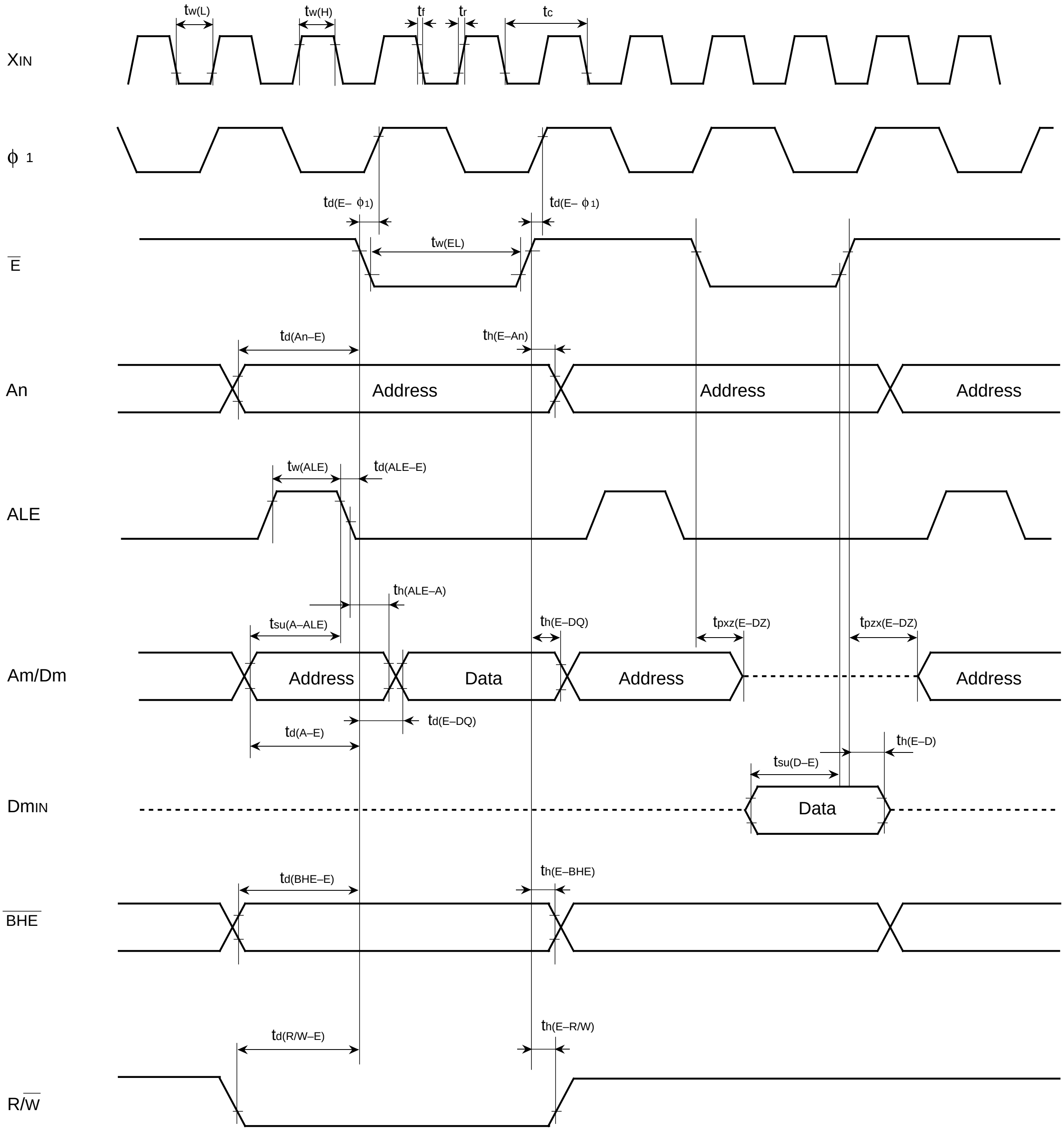


(When wait bit = “1” or “0” in common)



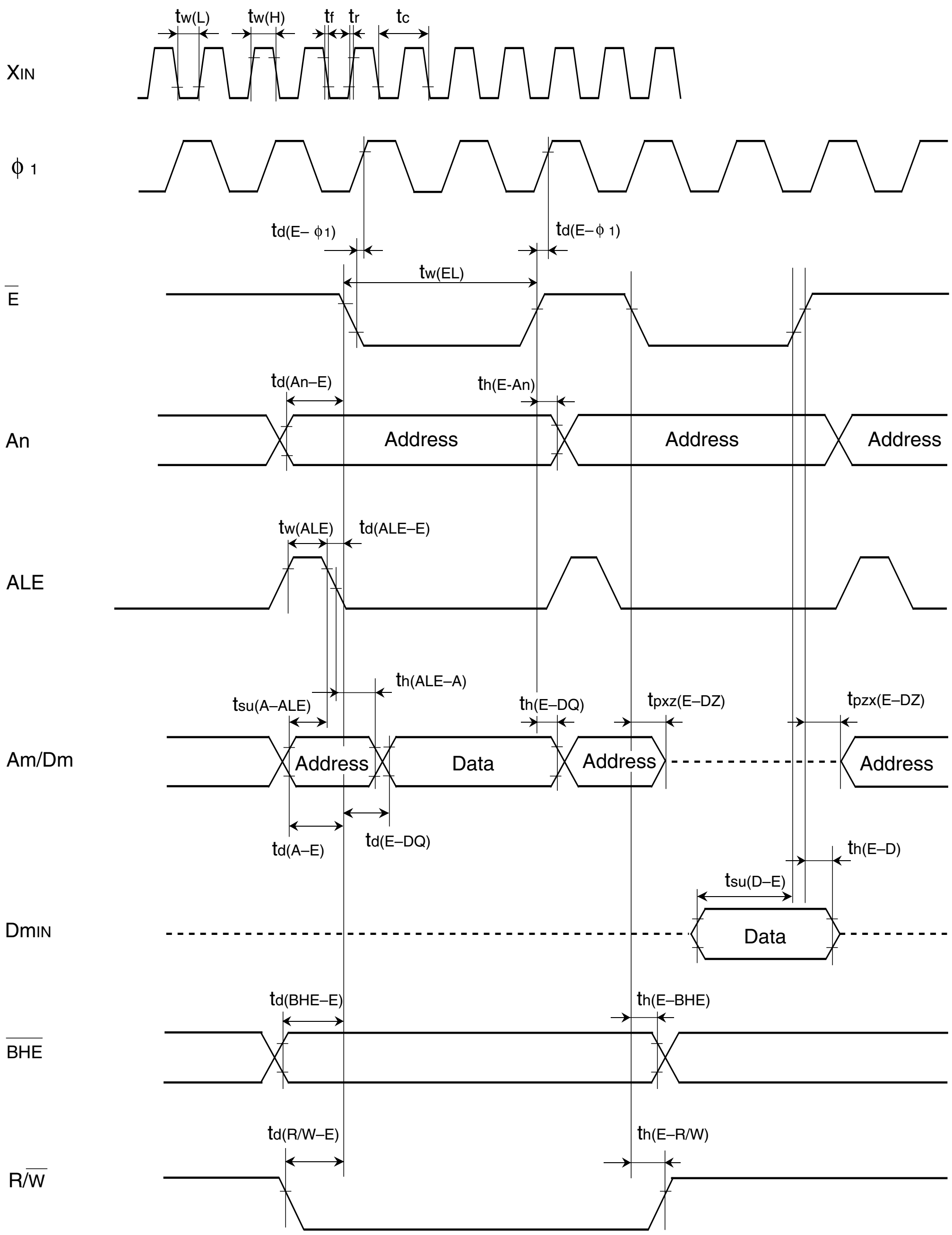
Test conditions
- V_{CC} = 2.7 – 5.5 V
- Input timing voltage : V_{IL} = $0.2V_{CC}$, V_{IH} = $0.8V_{CC}$
- Output timing voltage : V_{OL} = 0.8 V, V_{OH} = 2.0 V

Microprocessor mode
(No wait : When wait bit = “1”)



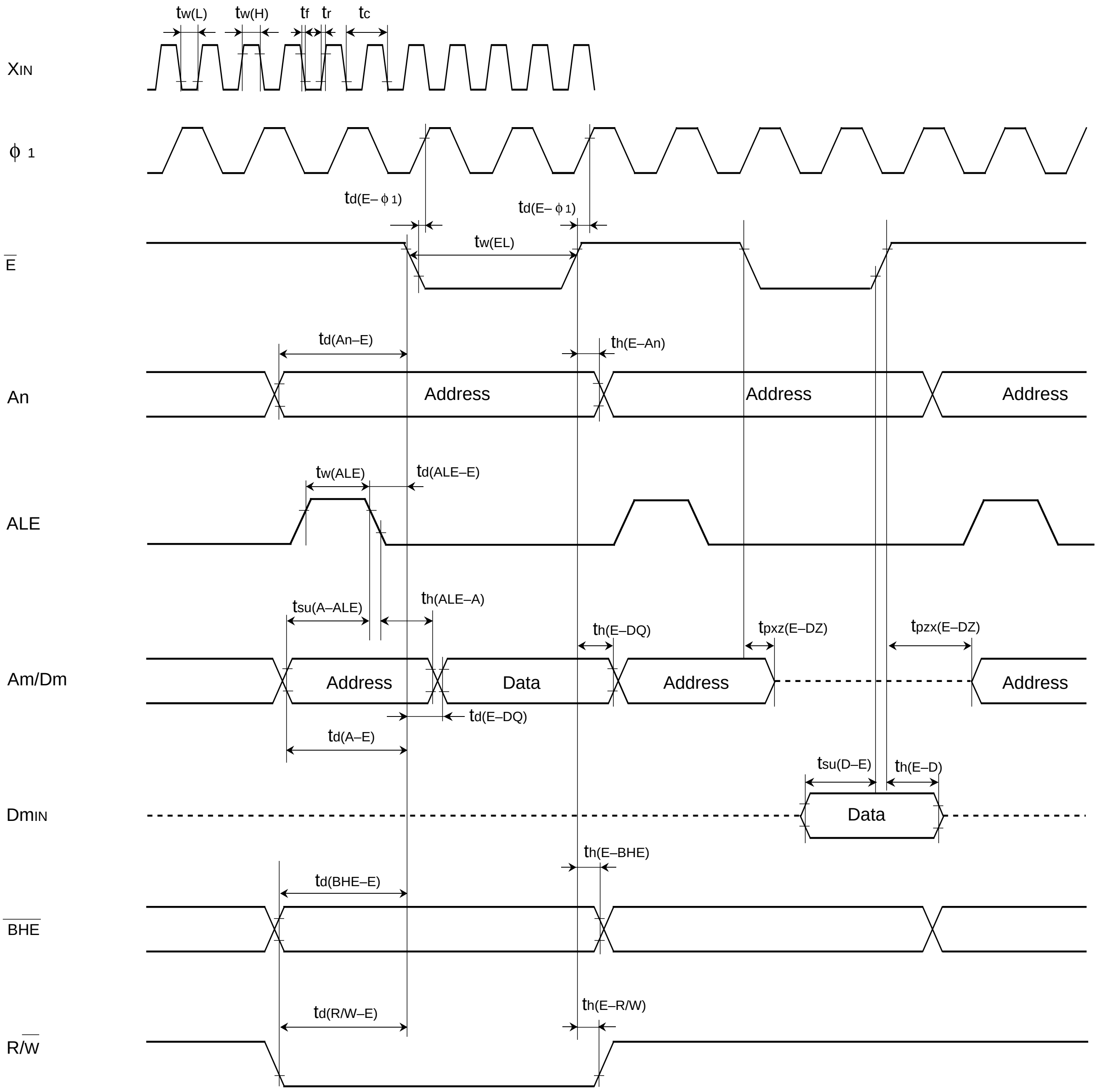
Test conditions
• Vcc = 2.7 – 5.5 V
• Output timing voltage : VOL = 0.8 V, VOH = 2.0 V
• Data input DmIN : VIL = 0.16VCC, VIH = 0.5VCC

Microprocessor mode
(Wait 1 : The external memory area is accessed when wait bit = “0” and wait selection bit = “1”.)



Test conditions
- Vcc = 2.7 – 5.5 V
- Output timing voltage : V_{OL} = 0.8 V, V_{OH} = 2.0 V
- Data input Dm_{IN} : V_{IL} = 0.16Vcc, V_{IH} = 0.5Vcc

Microprocessor mode
(Wait 0 : The external memory area is accessed when wait bit = “0” and wait selection bit = “0”.)



Test conditions
- V_{CC} = 2.7 – 5.5 V
- Output timing voltage : V_{OL} = 0.8 V, V_{OH} = 2.0 V
- Data input Dm_{IN} : V_{IL} = 0.16V_{CC}, V_{IH} = 0.5V_{CC}

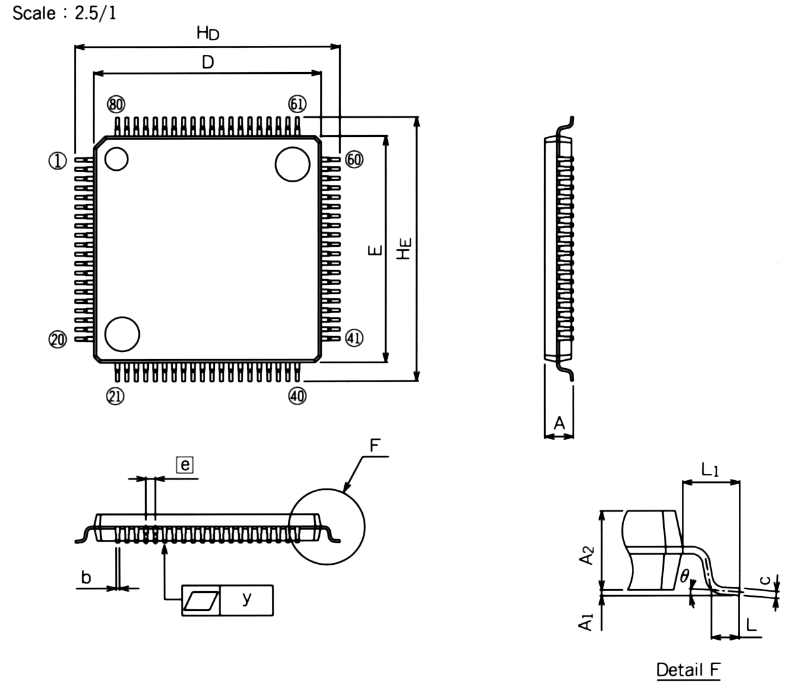
PACKAGE OUTLINE

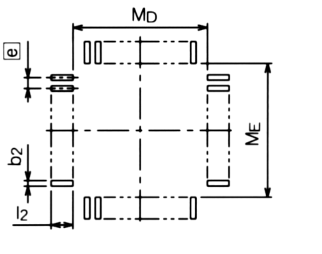
80P6D–A

Plastic 80pin 12×12mm body LQFP

EIAJ Package Code	JEDEC Code	Weight(g)	Lead Material
LQFP80-P-1212-0.50	–	0.44	Alloy 42

Scale : 2.5/1





Recommended Mount Pad

Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	–	–	1.7
A_1	0	0.1	0.2
A_2	–	1.4	–
b	0.13	0.18	0.28
c	0.105	0.125	0.175
D	11.9	12.0	12.1
E	11.9	12.0	12.1
e	–	0.5	–
H_D	13.8	14.0	14.2
H_E	13.8	14.0	14.2
L	0.3	0.5	0.7
L_1	–	1.0	–
y	–	–	0.1
θ	0°	–	10°
b_2	–	0.225	–
l_2	1.0	–	–
M_D	–	12.4	–
M_E	–	12.4	–

MEMO

MEMO

New product

Renesas Technology Corp.
Nippon Bldg.,6-2,Otemachi 2-chome,Chiyoda-ku,Tokyo,100-0004 Japan

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